Digital MEMS Vibration Sensor with Embedded RF Transceiver

Data Sheet

ADIS16000/ADIS16229

FEATURES

Wireless vibration system, 902.5 MHz to 927.5 MHz
   Clear channel assessment and packet collision avoidance
   Error detection and correction in radio frequency (RF)
      protocol
   Programmable RF output power
Gateway node (ADIS16000)
   SPI to RF function
   Manage up to 6 sensor nodes
Sensor node (ADIS16229)
   Dual axis, ±18 *g* MEMS accelerometer
   5.5 kHz sensor resonant frequency
   Digital FFT range settings: 1 *g*, 5 *g*, 10 *g*, and 20 *g*
   Sample rate up to 20 kSPS
   Programmable wake-up capture, update cycle times
   512-point, real valued FFT
   Rectangular, Hanning, and flat top window options
   Programmable decimation filter, 11 rate settings
   Multirecord capture for selected filter settings
   Manual capture mode for time domain data collection
   Programmable FFT averaging of up to 255 averages
   Record storage: 14 FFT records on two axes (x and y)
   Programmable alarms, 6 spectral bands, 2 levels
   Adjustable response delay to reduce false alarms
   Internal self-test with status flags
   Digital temperature and power supply measurements
   Identification registers: serial number, device ID, user ID
37.8 mm × 22.8 mm × 8.8 mm MCML package (ADIS16000)
37.8 mm × 22.8 mm × 13.5 mm MCML package (ADIS16229)
Single-supply operation: 3.0 V to 3.6 V
Operating temperature range of −40°C to +85°C

APPLICATIONS

Vibration analysis
Condition monitoring
Machine health
Instrumentation and diagnostics
Safety shutoff sensing

GENERAL DESCRIPTION

The ADIS16000 and ADIS16229 enable the creation of a simple wireless vibration sensing network for a wide variety of industrial equipment applications. The ADIS16000 provides the gateway function, which manages the network, while the ADIS16229 provides the remote sensing function.

The ADIS16229 *i*Sensor® is a complete wireless vibration sensor node that combines dual axis acceleration sensing with advanced time domain and frequency domain signal processing. Time domain signal processing includes a programmable decimation filter and selectable windowing function. Frequency domain processing includes a 512-point, real valued fast Fourier transform (FFT); FFT magnitude averaging; and programmable spectral alarms. The FFT record storage system offers users the ability to track changes over time and capture FFTs with multiple decimation filter settings.

The dynamic range, bandwidth, sample rate, and noise perfor-mance of the ADIS16229 are well suited for a wide variety of machine health and production equipment monitoring systems. This device also provides a number of wireless configuration parameters, enabling a wide level of flexibility in managing the trade-off between battery life and communication frequency.

The ADIS16000 serial peripheral interface (SPI) provides simple connectivity with most embedded processor platforms, and the SMA connector interface enables the use of many different anten-nas. This module supports up to six ADIS16229 devices at one time, using a proprietary wireless protocol.

The ADIS16000 module is available in a 37.8 mm × 22.8 mm × 8.8 mm multichip chip module laminate (MCML) structure, and the ADIS16229 is available in a 37.8 mm × 22.8 mm × 13.5 mm MCML structure. Both have an SMA connector for simple antenna connection, have two mounting holes for simple installation, and support operation over a −40°C to +85°C temperature range. The ADIS16000 also includes a standard 1 mm, 14-pin connector for connecting to an embedded processor system. The ADIS16229 provides a lead structure that enables simple connection with battery leads.

Document Feedback

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.
Tel: 781.329.4700   ©2013 Analog Devices, Inc. All rights reserved.
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REVISION HISTORY

8/13—Revision 0: Initial Version

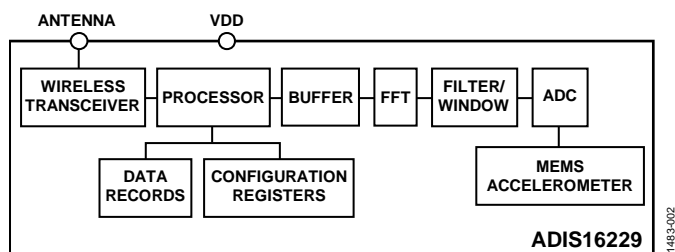# FUNCTIONAL BLOCK DIAGRAMS
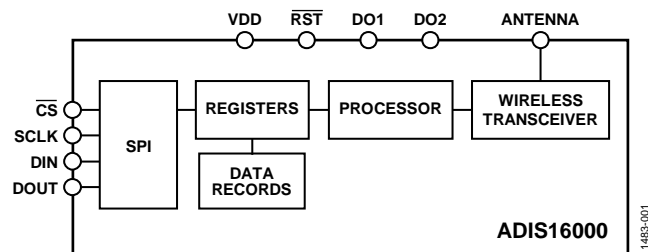
Figure 1. ADIS16000 Block Diagram

Figure 2. ADIS16229 Block Diagram

SPECIFICATIONS

T_A = −40°C to +85°C, VDD = 3.3 V, unless otherwise noted.

Table 1.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
ACCELEROMETERS (ADIS16229)					
Measurement Range[1]	T_A = 25°C	±18			g
Sensitivity, FFT	T_A = 25°C, 0 g to 20 g range setting		0.3052		mg/LSB
Sensitivity, Time Domain	T_A = 25°C		0.6104		mg/LSB
Sensitivity Error	T_A = 25°C		±0.3		%
	−40°C ≤ T_A ≤ +85°C			±6	%
Nonlinearity	With respect to full scale		±0.2	±1.25	%
Cross-Axis Sensitivity			4		%
Alignment Error	With respect to package mounting holes		2.3		Degrees
Offset Error	T_A = 25°C		±0.01		g
	−40°C ≤ T_A ≤ +85°C			±1	g
Offset Temperature Coefficient			2		mg/°C
Output Noise	T_A = 25°C, 20.48 kHz sample rate, time domain		11		mg rms
Output Noise Density	T_A = 25°C, 10 Hz to 1 kHz		0.248		mg/√Hz
Bandwidth	±5% flatness, see Figure 21		840		Hz
Sensor Resonant Frequency			5.5		kHz
LOGIC INPUTS[2] (ADIS16000)					
Input High Voltage, V_{INH}		0.7 × VDD			V
Input Low Voltage, V_{INL}				0.2 × VDD	V
Input Leakage Current			0.01		µA
$\overline{RST}$, SCLK			0.1		mA
Input Capacitance, C_{IN}			10		pF
DIGITAL OUTPUTS[2] (ADIS16000)					
Output High Voltage, V_{OH}	I_{SOURCE} = 1 mA	VDD − 0.4			V
Output Low Voltage, V_{OL}	I_{SINK} = 1 mA			0.36	V
FLASH MEMORY					
Endurance[3]		20,000			Cycles
Data Retention[4]	T_J = 85°C, see Figure 25	20			Years
START-UP TIME[5]					
Initial Startup	ADIS16000		80		ms
	ADIS16229		150		ms
Reset Recovery[6]	ADIS16000		80		ms
	ADIS16229		80		ms
Sleep Mode Recovery	ADIS16229		25		ms
SAMPLE RATE	Internal sample rate		20		kSPS
Clock Accuracy			3		%
TRANSCEIVER					
Receiver Sensitivity	−40°C ≤ T_A ≤ +85°C		−92		dBm
Transmission Power		−18		−10.5	dBm

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
POWER SUPPLY	Operating voltage range, VDD	3.0	3.3	3.6	V
Power Supply Current, ADIS16000	Transmission mode, 10 dBm, 25℃		37		mA
	Transmission mode, −1 dBm, 25℃		18		mA
	Receive mode, 25℃		20		mA
Power Supply Current, ADIS16229	Transmission mode, 10 dBm, 25℃		39	41	mA
	Transmission mode, 10 dBm, −40℃ to +85℃		37.5		mA
	Transmission mode, −1 dBm, 25℃		19	26	mA
	Transmission mode, −1 dBm, −40℃ to +85℃	4	19.5		mA
	Receive mode, 25℃		20.5	26	mA
	Receive mode, −40℃ to +85℃		21.5		mA
	Data capture mode, no transceiver activity, 25℃		7.2		mA
	Sleep mode, T$_A$ = 25℃		2.5		μA

[1] The maximum range depends on the frequency of vibration.
[2] The digital input/output signals are 5 V tolerant.
[3] Endurance is qualified as per JEDEC Standard 22, Method A117, and measured at −40℃, +25℃, +85℃, and +125℃.
[4] Retention lifetime equivalent at junction temperature (T$_J$) = 85℃ as per JEDEC Standard 22, Method A117. Retention lifetime depends on junction temperature.
[5] The start-up times presented reflect the time it takes for data collection to begin.
[6] Applies to the reset line ($\overline{RST}$ = 0) and the software reset command (GLOB_CMD_G[7] = 1). The $\overline{RST}$ pin must be held low for at least 10 μs.

TIMING SPECIFICATIONS

T_A = 25°C, VDD = 3.3 V, unless otherwise noted. See Figure 3 and Figure 4.

Table 2.

| Parameter	Description	Min	Typ	Max	Unit
f_{SCLK}	SCLK frequency			2.5	MHz
t_{STALL}	Stall time	30			μs
$t_{\overline{CS}}$	$\overline{CS}$ to SCLK edge	12.9			ns
t_{SL}	SCLK low pulse width, not shown in figures		500		ns
t_{SH}	SCLK high pulse width, not shown in figures		500		ns
t_{DAV}	Data output valid after SCLK edge			47.4	ns
t_{DSU}	Data input setup time before SCLK edge	25.8			ns
t_{DHD}	Data input hold time after SCLK edge	12.9			ns
t_{DF}	Data output fall time, not shown in figures		10.6	32.0	ns
t_{DR}	Data output rise time, not shown in figures		10.6	32.0	ns
t_{SR}	SCLK rise time		10.6	32.0	ns
t_{SF}	SCLK fall time		10.6	32.0	ns
t_{DOCS}	Data output valid after $\overline{CS}$ edge, not shown in figures			59.8	ns
t_{SFS}	$\overline{CS}$ high after SCLK edge	12.9			ns

Timing Diagrams
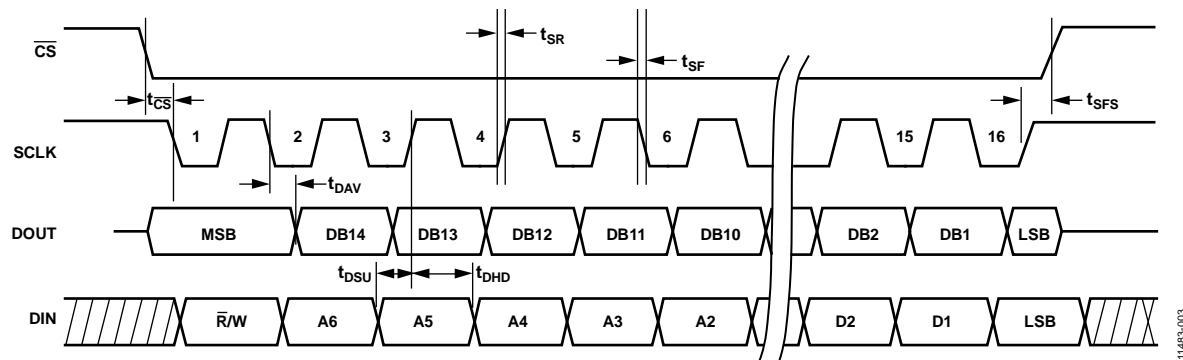
Figure 3. SPI Timing and Sequence
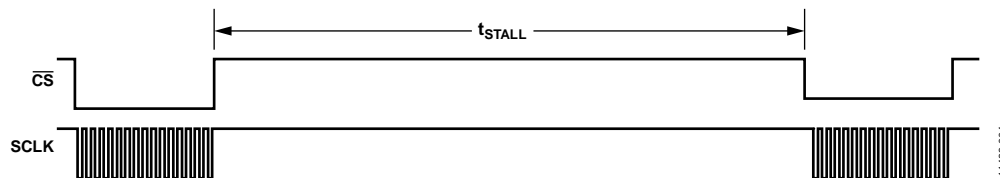
Figure 4. DIN Bit Sequence

ABSOLUTE MAXIMUM RATINGS

Table 3.

Parameter	Rating
Acceleration	
Any Axis, Unpowered	2000 *g*
Any Axis, Powered	2000 *g*
VDD to GND	−0.3 V to +3.96 V
Digital Input Voltage to GND	−0.3 V to +3.96 V
Digital Output Voltage to GND	−0.3 V to +3.96 V
Temperature	
Operating Temperature Range	−40°C to +85°C
Storage Temperature Range	−65°C to +150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 4. Package Characteristics

Package Type	θ_{JA}	θ_{JC}	Device Weight
14-Pin MCML	31°C/W	11°C/W	6.5 grams

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS
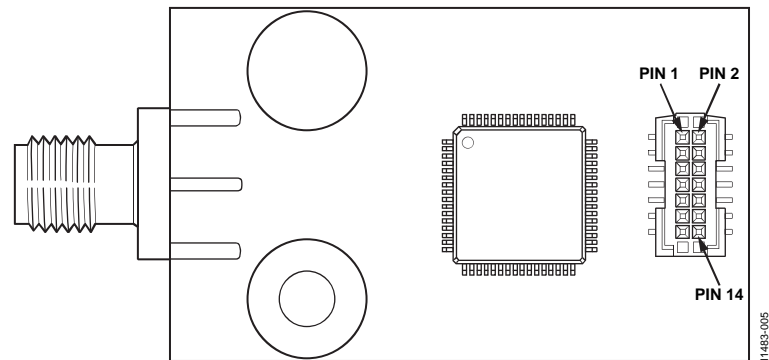
Figure 5. ADIS16000 Pin Locations
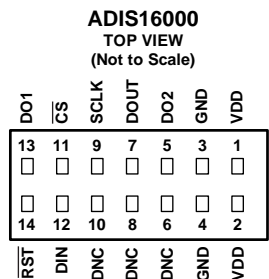
NOTES
1. THIS REPRESENTATION DISPLAYS THE TOP VIEW WHEN THE
   CONNECTOR IS VISIBLE AND FACING UP.
2. MATING CONNECTOR: ML-14-4 OR EQUIVALENT.
3. DNC = DO NOT CONNECT.

Figure 6. ADIS16000 Pin Configuration

Table 5. ADIS16000 Pin Function Descriptions

Pin No.	Mnemonic	Type[1]	Description
1, 2	VDD	S	Power Supply, 3.3 V.
3, 4	GND	S	Ground.
5	DO2	O	Digital Output Line 2.
6, 8, 10	DNC	N/A	Do not connect to these pins.
7	DOUT	O	SPI, Data Output. When $\overline{CS}$ is low, DOUT is an output, and when $\overline{CS}$ is high, DOUT goes into a three-state, high impedance mode.
9	SCLK	I	SPI, Serial Clock.
11	$\overline{CS}$	I	SPI, Chip Select.
12	DIN	I	SPI, Data Input.
13	DO1	O	Digital Output Line 1.
14	$\overline{RST}$	I	Reset, Active Low.

[1] S = supply, O = output, I = input, and N/A = not applicable.
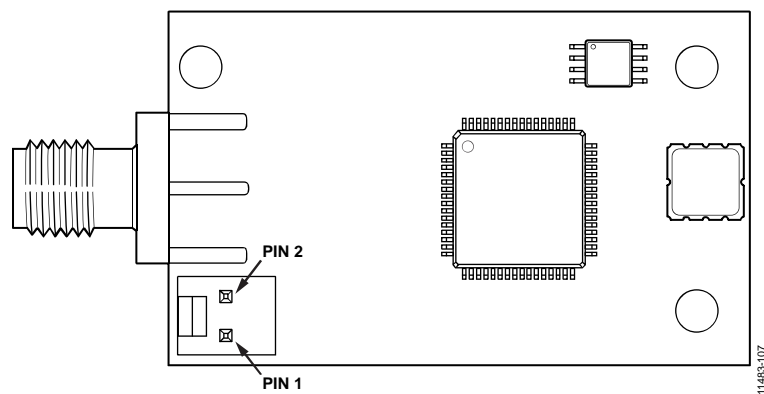
Figure 7. ADIS16229 Pin Locations

Table 6. ADIS16229 Pin Function Descriptions

Pin No.	Mnemonic	Type[1]	Description
1	VDD	S	Power Supply, 3.3 V
2	GND	S	Ground

[1] S = supply.

THEORY OF OPERATION

The ADIS16000 is the gateway node, and the ADIS16229 serves as the remote sensor node in a wireless vibration monitoring system. Using a proprietary wireless protocol, one ADIS16000 can support up to six ADIS16229 nodes at one time in a local star network configuration (see Figure 9). As the gateway node, the SPI interface of the ADIS16000 provides access to an addressable register map that manages configuration parameters (gateway and sensor node), remote alarm flags, and remote vibration data. The SPI interface of the ADIS16000 enables simple connection to most embedded processors, and its standard SMA connector supports direct connection to a wide variety of antennas. The ADIS16229 requires only an antenna and battery to start up and connect with the ADIS16000 to begin operation.

SENSING ELEMENT

Digital vibration sensing in the ADIS16229 starts with a MEMS accelerometer core on two different axes. Accelerometers translate linear changes in velocity into a representative electrical signal, using a micromechanical system like the one shown in Figure 8. The mechanical part of this system includes two different frames, one fixed and one moving, that have a series of plates to form a variable, differential capacitive network. When experiencing the force associated with gravity or acceleration, the moving frame changes its physical position with respect to the fixed frame, which results in a change in capacitance. Tiny springs tether the moving frame to the fixed frame and govern the relationship between acceleration and physical displacement. A modulation signal on the moving plate feeds through each capacitive path into the fixed frame plates and into a demodulation circuit, which produces the electrical signal that is proportional to the acceleration acting on the device.
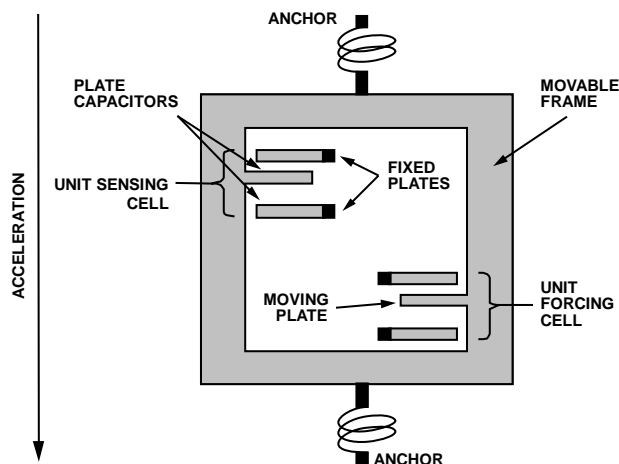
Figure 8. MEMS Sensor Diagram

SIGNAL PROCESSING

Figure 10 offers a simplified block diagram for the ADIS16229. The signal processing stage includes time-domain data capture, digital decimation/filtering, windowing, FFT analysis, FFT averaging, and record storage. See Figure 18 for more details on the signal processing operation.

SENSOR COMMUNICATION

The ADIS16000 provides access to the ADIS16229 through dedicated pages in the register structure. When the ADIS16000 communicates with a remote ADIS16229, it copies all configuration information in these registers to their respective locations in the ADIS16229 and acquires all of the data in the output registers and data records of the ADIS16229.
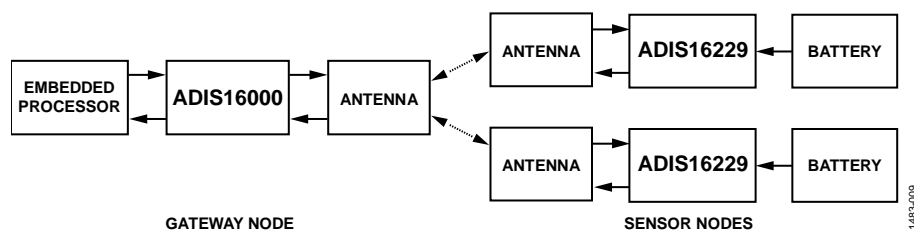
Figure 9. Star Wireless Network Example
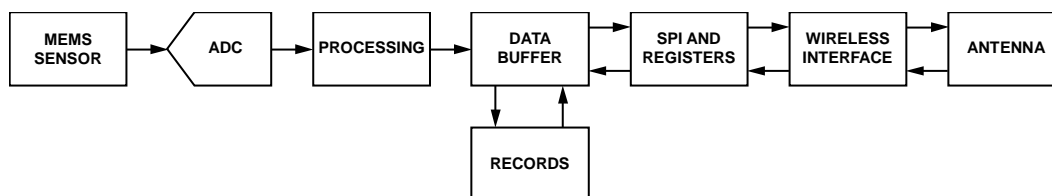
Figure 10. ADIS16229 Simplified Block Diagram

GATEWAY COMMUNICATION

SPI Interface

The data collection and configuration command uses the SPI, which consists of four wires. The chip select ($\overline{CS}$) signal activates the SPI interface, and the serial clock (SCLK) synchronizes the serial data lines. Input commands clock into the DIN pin, one bit at a time, on the SCLK rising edge. Output data clocks out of the DOUT pin on the SCLK falling edge. Because the ADIS16000 serves only as an SPI slave, the DOUT contents reflect the information requested using a DIN command.

Register Organization

The memory map for the ADIS16000 contains seven pages of user accessible registers, which enable simple organization of both local (gateway) and remote (sensor) functions. Each page has a page control register (PAGE_ID), which is located at Address 0x00. The contents in this location contain the number that represents the active page. For example, if Address 0x00 has 0x05 in it, Page 5 is the active page. Change the active page assignment by writing a new value (between 0x00 and 0x06) to Address 0x00. For example, write 0x02 to Address 0x00 (DIN = 0x8002) to gain access to the registers in Page 2.

Each 16-bit register has its own unique bit assignment and two addresses: one for its upper byte and one for its lower byte. Table 10 and Table 11 provide more details on these memory maps, which list each register, along with its function and lower byte address.

Table 7. ADIS16000 Register Map Page Organization

PAGE_ID	Function	Reference
0x0000	Gateway configuration	Table 10
0x0001	Sensor Node 1	Table 11
0x0002	Sensor Node 2	Table 11
0x0003	Sensor Node 3	Table 11
0x0004	Sensor Node 4	Table 11
0x0005	Sensor Node 5	Table 11
0x0006	Sensor Node 6	Table 11

Dual Memory Structure

The user registers provide addressing for all input/output operations in the SPI interface. The control registers use a dual memory structure (see Figure 11). The controller uses static random access memory (SRAM) registers for normal operation, including user configuration commands. The flash memory provides nonvolatile storage for control registers that have flash backup (see Table 10 and Table 11). When the device powers on or resets, the flash memory contents load into the SRAM, and the device starts producing data according to the configuration in the control registers. Storing configuration data in the flash memory requires a manual flash update command. For the ADIS16000, set DIN = 0x8000 (access Page 0), then set DIN = 0x9240 (set GLOB_CMD_S[6] = 1). For a remote ADIS16229, use the following steps to update its flash:

1. Turn to its page (for example, set DIN = 0x8001 to access Sensor Node 1).
2. Set DIN = 0xB640 (GLOB_CMD_S[6] = 1).
3. Set DIN = 0x8000 (turn to Page 0).
4. Set DIN = 0x9202 (GLOB_CMD_G[1] = 1).

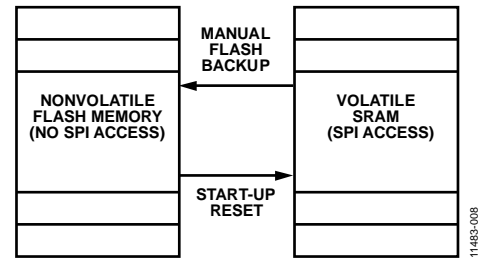Figure 11. SRAM and Flash Memory Diagram

BASIC OPERATION OF THE ADIS16000

When the ADIS16000 has appropriate power on the VDD pin, it automatically begins a self-initialization process. When this process is completed, the SPI interface is activated and provides access to its register structure. The SPI interface supports connectivity with most embedded processor platforms, using the connection diagram in Figure 12. The factory default configuration for DO1 provides a busy indicator signal that indicates when to avoid SPI communication requests.
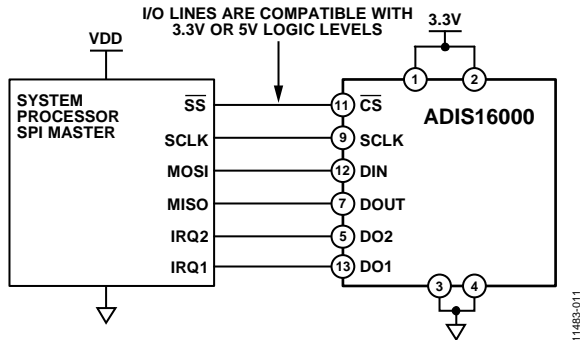
Figure 12. Electrical Hook-Up Diagram

Table 8. Generic Master Processor Pin Names and Functions

Pin Name	Function
$\overline{SS}$	Slave select
SCLK	Serial clock
MOSI	Master output, slave input
MISO	Master input, slave output
IRQ1, IRQ2	Interrupt request inputs (optional)

The ADIS16000 SPI interface supports full duplex serial communication (simultaneous transmit and receive) and uses the bit sequence shown in Figure 16. Table 9 provides a list of the most common settings that require attention to initialize a processor serial port for the ADIS16000 SPI interface.

Table 9. Generic Master Processor SPI Settings

Processor Setting	Description
Master	ADIS16000 operates as slave
SCLK Rate ≤ 2.5 MHz	Bit rate setting
SPI Mode 3	Clock polarity/phase (CPOL = 1, CPHA = 1)
MSB First	Bit sequence
16-Bit	Shift register/data length

Table 10 and Table 11 provide lists of user registers with their lower byte addresses. Each register consists of two bytes, each of which has its own unique 7-bit address. Figure 13 relates the bits of each register to their upper and lower addresses.
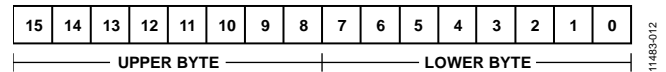
Figure 13. Generic Register Bit Definitions

SPI WRITE COMMANDS

User control registers govern many internal operations. The DIN bit sequence in Figure 16 provides the ability to write to these registers, one byte at a time. Some configuration changes and functions require only one write cycle. For example, set PAGE_ID[7:0] = 1 (DIN = 0x8001) to select Page 1 of the register map.
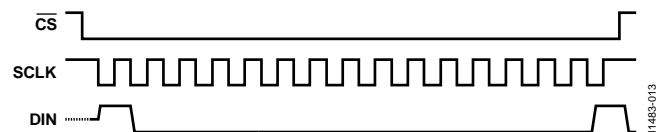
Figure 14. SPI Sequence for Selecting Page 1 for Access (DIN = 0x8001)

SPI READ COMMANDS

A single register read requires two 16-bit SPI cycles that also use the bit assignments shown in Figure 16. The first sequence sets $\overline{R}/W$ = 0 and communicates the target address (Bits[A6:A0]). Bits[D7:D0] are don't care bits for a read DIN sequence. DOUT clocks out the requested register contents during the second sequence. The second sequence can also use DIN to set up the next read. Figure 15 provides a signal diagram for all four SPI signals while reading the PROD_ID_G. In this diagram, DIN = 0x1600 and DOUT reflects the decimal equivalent of 16,000.

DOUT = 0011 1110 1000 0000 = 0x3E80 = 16,000 = PROD_ID_G

Figure 15. Example SPI Read, PROD_ID_G (Page 0), Second Sequence

NOTES
1. DOUT BITS ARE BASED ON THE PREVIOUS 16-BIT SEQUENCE ($\overline{R}/W$ = 0).

Figure 16. Example SPI Read Sequence

Table 10. User Register Memory Map, PAGE_ID = 0x0000

Register Name	Access[1]	Flash Backup[1]	Address	Default[1]	Function	Reference
PAGE_ID	Read/write	N/A	0x00	0x0000	Page identifier	Table 7
NETWORK_ID	Read/write	Yes	0x02	0x1234	Network identifier, unique to a network	Table 14
FLASH_CNT_G	Read only	Yes	0x04	N/A	Flash update counter	Table 87
NW_ERROR_STAT	Read only	No	0x06	0x0000	Network error indicators	Table 26
TX_PWR_CTRL_G	Read/write	Yes	0x08	0x0008	Transmission power control, gateway	Table 18
RSSI_G	Read only	No	0x0A	N/A	Received signal strength	Table 16
TEMP_OUT_G	Read only	No	0x0C	N/A	Output, temperature	Table 67
SUPPLY_OUT_G	Read only	No	0x0E	N/A	Output, supply voltage	Table 64
TEST_MODE	Read/write	Yes	0x10	0x0000	FCC test support modes	Table 23
GLOB_CMD_G	Write only	No	0x12	N/A	System commands	Table 13
CMD_DATA	Read/write	No	0x14	0x0000	Data to sensor nodes	Table 12
PROD_ID_G	Read only	Yes	0x16	0x3E80	Product identifier, ADIS16000	Table 80
Reserved	N/A	No	0x18	N/A	Reserved	
LOT_ID1_G	Read only	No	0x1A	N/A	Lot Identifier 1	Table 76
LOT_ID2_G	Read only	No	0x1C	N/A	Lot Identifier 2	Table 78
Reserved	N/A	No	0x1E	N/A	Reserved	
Reserved	N/A	No	0x20	N/A	Reserved	
Reserved	N/A	No	0x22	N/A	Reserved	
SERIAL_NUM_G	Read only	No	0x24	N/A	Serial number, lot specific	Table 82
Reserved	N/A	No	0x26	N/A	Reserved	
Reserved	N/A	No	0x28	N/A	Reserved	
GPO_CTRL	Read/write	Yes	0x2A	0x0008	General-purpose output control	Table 84
DIAG_STAT_G	Read only	No	0x2C	0x0000	Diagnostics, status flags	Table 85

[1] N/A = not applicable.

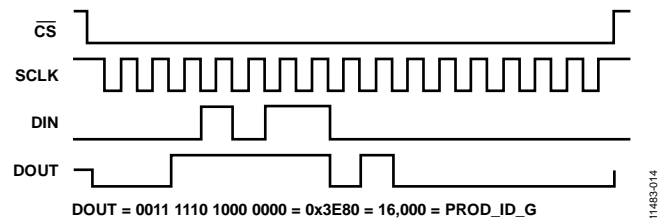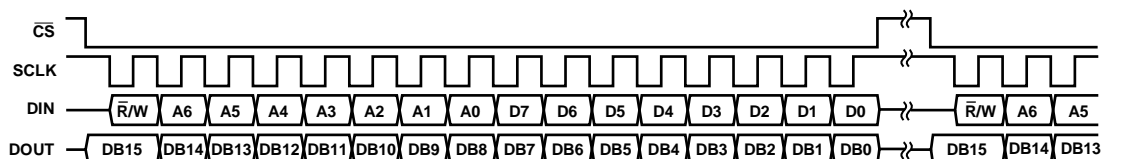Table 11. User Register Memory Map, PAGE_ID ≥ 0x0001 (Registers Representing Remote ADIS16229 Units)

Register Name	Access[1]	Flash Backup[1]	Address	Default[1, 2]	Function	Reference
PAGE_ID	Read/write	N/A	0x00	N/A	Page identifier	Table 7
SENS_ID	Read only	Yes	0x02	N/A	Sensor identifier	Table 15
FLASH_CNT_S	Read only	Yes	0x04	N/A	Status, flash memory write count	Table 88
X_BUF	Read only	No	0x06	N/A	Output, buffer for x-axis acceleration data	Table 60
Y_BUF	Read only	No	0x08	N/A	Output, buffer for y-axis acceleration data	Table 61
TEMP_OUT_S	Read only	No	0x0A	N/A	Output, temperature during capture	Table 68
SUPPLY_OUT_S	Read only	No	0x0C	N/A	Output, power supply during capture	Table 65
FFT_AVG1	Read/write	Yes	0x0E	0x0108	Control, FFT average, SR0 and SR1	Table 35
FFT_AVG2	Read/write	Yes	0x10	0x0101	Control, FFT average, SR2 and SR3	Table 36
BUF_PNTR	Read/write	No	0x12	0x0000	Control, buffer address pointer	Table 58
REC_PNTR	Read/write	No	0x14	0x0000	Control, record address pointer	Table 59
X_SENS	Read/write	No	0x16	N/A	Control, x-axis scale correction factor	Table 33
Y_SENS	Read/write	No	0x18	N/A	Control, y-axis scale correction factor	Table 34
REC_CTRL1	Read/write	Yes	0x1A	0x1102	Record control register	Table 28
REC_CTRL2	Read/write	Yes	0x1C	0x00FF	Record control register	Table 31
Reserved	N/A	No	0x1E	N/A	Reserved	
ALM_F_LOW	Read/write	Yes	0x20	0x0000	Spectral alarm band, low frequency	Table 44
ALM_F_HIGH	Read/write	Yes	0x22	0x0000	Spectral alarm band, high frequency	Table 45
ALM_X_MAG1	Read/write	Yes	0x24	0x0000	Spectral alarm band, X-Axis Alarm Trigger Level 1 magnitude	Table 46
ALM_Y_MAG1	Read/write	Yes	0x26	0x0000	Spectral alarm band, Y-Axis Alarm Trigger Level 1 magnitude	Table 47
ALM_X_MAG2	Read/write	Yes	0x28	0x0000	Spectral alarm band, X-Axis Alarm Trigger Level 2 magnitude	Table 48

Register Name	Access[1]	Flash Backup[1]	Address	Default[1, 2]	Function	Reference
ALM_Y_MAG2	Read/write	Yes	0x2A	0x0000	Spectral alarm band, Y-Axis Alarm Trigger Level 2 magnitude	Table 49
ALM_PNTR	Read/write	No	0x2C	0x0000	Spectral alarm band pointer	Table 43
ALM_S_MAG	Read/write	Yes	0x2E	0x0000	Alarm, system alarm trigger level	Table 50
ALM_CTRL	Read/write	Yes	0x30	0x0080	Alarm, control register	Table 42
AVG_CNT	Read/write	Yes	0x32	0x9630	Sample rate control (average count)	Table 29
DIAG_STAT_S	Read only	No	0x34	0x0000	System status register	Table 86
GLOB_CMD_S	Write only	No	0x36	N/A	Global command register	Table 75
ALM_X_STAT	Read only	No	0x38	0x0000	Alarm, x-axis status register	Table 51
ALM_Y_STAT	Read only	No	0x3A	0x0000	Alarm, y-axis status register	Table 52
ALM_X_PEAK	Read only	No	0x3C	0x0000	Alarm, x-axis peak level	Table 53
ALM_Y_PEAK	Read only	No	0x3E	0x0000	Alarm, y-axis peak level	Table 54
TIME_STMP_L	Read only	No	0x40	0x0000	Time stamp, low integer	Table 73
TIME_STMP_H	Read only	No	0x42	0x0000	Time stamp, high integer	Table 74
ALM_X_FREQ	Read only	No	0x44	0x0000	Alarm frequency of x-axis ALM_X_PEAK	Table 55
ALM_Y_FREQ	Read only	No	0x46	0x0000	Alarm frequency of y-axis ALM_Y_PEAK	Table 56
PROD_ID_S	Read only	Yes	0x48	0x3F65	Product identification register	Table 81
REC_FLSH_CNT	Read only	No	0x4A	N/A	Flash write cycle count	Table 40
REC_INFO1	Read only	No	0x4C	0x0008	Record Settings 1	Table 71
REC_INFO2	Read only	No	0x4E	0x0000	Record Settings 2	Table 72
REC_CNTR	Read only	No	0x50	0x0000	Record counter	Table 38
PKT_TIME_L	Read only	No	0x52	N/A	Received packet time stamp, low integer	Table 24
PKT_TIME_H	Read only	No	0x54	N/A	Received packet time stamp, high integer	Table 25
PKT_ERROR_STAT	Read only	No	0x56	0x0000	Missed packets/error indicator	Table 27
TX_PWR_CTRL_S	Read/write	Yes	0x58	0x0008	Transmission power control	Table 19
RSSI_S	Read only	No	0x5A	N/A	Received signal strength indicator	Table 17
RF_MODE	Read/write	Yes	0x5C	0x0000	Wireless communication configuration	Table 20
UPDAT_INT	Read/write	Yes	0x5E	0x0FA0	Update interval	Table 21
INT_SCL	Read/write	Yes	0x60	0x0001	Update interval scale	Table 22
Reserved	N/A	N/A	0x62	N/A	Reserved	
USER_SCR	Read only	Yes	0x64	0x0000	User scratch register	Table 83
Reserved	N/A	N/A	0x66	N/A	Reserved	
LOT_ID1_S	Read only	Yes	0x68	N/A	Lot Identification Code 1	Table 77
LOT_ID2_S	Read only	Yes	0x6A	N/A	Lot Identification Code 2	Table 79
Reserved	N/A	N/A	0x6C	N/A	Reserved	
Reserved	N/A	N/A	0x6E	N/A	Reserved	

[1] N/A = not applicable.
[2] All registers in Page 1, Page 2, Page 3, Page 4, Page 5, and Page 6 read 0x0000 prior to connecting with the ADIS16229.

NETWORK MANAGEMENT

When the ADIS16000 and the ADIS16229 have an appropriate supply voltage across their VDD and GND pins, they both self-initialize and prepare themselves for connecting. After completing this process, the ADIS16229 starts sending connection requests to any available ADIS16000 devices within range. The system microcontroller manages the response of the ADIS16000 to these requests, using the CMD_DATA (see Table 12) and GLOB_CMD_G registers (see Table 13), which are both in Page 0 of the ADIS16000. Adding an ADIS16229 network requires the following two steps:

1. Set GLOB_CMD_G[0] = 1 (DIN = 0x9201, in Page 0).
2. Wait 500 µs and then write the node number (between 0 and 6) to the CMD_DATA register.

After this second step, the connection process can take up to 10 seconds after writing this code. Removing a sensor from the network uses a similar two-step process: write the sensor node number to the CMD_DATA register, and then set GLOB_CMD_G[8] = 1 (DIN = 0x9301, Page 0).

Table 12. CMD_DATA,
Page 0, Low Byte Address = 0x14, Read/Write

Bits	Description (Default = 0x0000)
[15:4]	Not used
[3:0]	Sensor node for GLOB_CMD_G[1] and GLOB_CMD_G[0] commands, range = 000 (0) to 110 (6)

Table 13. GLOB_CMD_G,
Page 0, Low Byte Address = 0x12, Write Only

Bits	Description (Default = Not Applicable)
15	Remove the sensor node identified by the CMD_DATA register
14	Not used
13	Request current configuration and payload from the sensor node identified by the CMD_DATA register
12	Manual update of alarm registers for the sensor node identified by the CMD_DATA register
11	Read alarm registers from the sensor node identified by the CMD_DATA register
10	Transfer alarm configuration from ADIS16000 page to remote sensor registers
9	Not used
8	Remove sensor node in CMD_DATA from the network
7	Software reset
6	Save registers to flash memory
5	Flash test, compare sum of flash memory with factory value
4	Clear DIAG_STAT_G register
3	Restore factory register settings, including capture buffer and alarm registers
2	Not used
1	Update sensor node in CMD_DATA register, in one of the manual modes
0	Add sensor node in CMD_DATA to the network

Set GLOB_CMD_G[1] = 1 (DIN = 0x9202) to initialize an update of all of the registers, except those associated with the spectral alarms. Set GLOB_CMD_G[12] = 1 (DIN = 0x9310) to update all of the alarm registers, after configuring them. Separating this function helps manage the flash memory endurance. The NETWORK_ID register (see Table 14) provides a user configurable identification number in its lower byte and provides a separate 8-bit number for application-specific information that does not influence the operation of the ADIS16000.

Table 14. NETWORK_ID,
Page 0, Low Byte Address = 0x02, Read/Write

Bits	Description (Default = 0x1234)
[15:8]	User configurable (no internal function)
[7:0]	User configurable, 8-bit network identification number

The SENS_ID register (see Table 15) contains the value 0x0000 when a particular page in the ADIS16000 memory map is not managing a specific ADIS16229 connection. When a page is managing a connection with an ADIS16229, the lower byte indicates the assigned node number within the network.

Table 15. SENS_ID,
Page 1 to Page 6, Low Byte Address = 0x02, Read Only

Bits	Description (Default = Not Applicable)
[15:8]	When connected, it is 0xAD.
[7:0]	Sensor node number. When connected, the range is 0 to 6.

Receiver Signal Strength

The RSSI_G and RSSI_S registers (see Table 16 and Table 17) provide tools for tuning the transmission power control at each location. Keep the transmission power high enough to maintain at least −92 dBm in these registers for best communication reliability.

Table 16. RSSI_G,
Page 0, Low Byte Address = 0x0A, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Received signal strength. This is a 16-bit twos complement number, where 0x0000 represents 0 dBm and each LSB represents 1 dBm of change in the received signal strength. Examples include the following: 0x0001 = +1 dBm. 0xFFFF = −1 dBm. 0xFFA0 = −92 dBm.

Table 17. RSSI_S,
Page 1 to Page 6, Low Byte Address = 0x5A, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Received signal strength. This is a 16-bit twos complement number, where 0x0000 represents 0 dBm and each LSB represents 1 dBm of change in the received signal strength. Examples include the following: 0x0001 = +1 dBm. 0xFFFF = −1 dBm. 0xFFA0 = −92 dBm.

Transmission Power Control

Both the ADIS16000 and ADIS16229 units provide controls for transmission power in the TX_PWR_CTRL_G (see Table 18) and TX_PWR_CTRL_S (see Table 19) registers. The registers provide users with the ability to optimize the transmission power for battery optimization and to manage interference influence on other networks. Note that compliance with FCC Part 15.247 involves limiting the transmission power to −1 dBm.

Table 18. TX_PWR_CTRL_G,
Page 0, Low Byte Address = 0x08, Read/Write

Bits	Description (Default = 0x0008)
[15:14]	Not used (don't care).
[13:8]	Channel frequency. This is a 6-bit, offset binary number that selects one of 51 channel frequencies. The lowest setting, 000000 (binary for 0 LSB), represents 902.5 MHz, and each LSB represents an increase of 0.5 MHz. The maximum setting, 110010 (binary for 50 LSB), selects a channel frequency of 927.5 MHz.
[7:5]	Not used (don't care).
[4:0]	Transmission power setting. This is a 5-bit, offset binary number that selects the transmission power in the gateway node. The lowest setting, 00000 (binary for 0 LSB), selects a transmission power of −15.5 dBm, and each LSB increases the transmission power by +1.7 dBm. The maximum setting, 01111, selects a transmission power of 10 dBm.

Table 19. TX_PWR_CTRL_S,
Page 1 to Page 6, Low Byte Address = 0x58, Read/Write

Bits	Description (Default = 0x0008)
[15:14]	Not used (don't care).
[13:8]	Channel frequency. This is a 6-bit, offset binary number that selects one of 51 channel frequencies. The lowest setting, 000000 (binary for 0 LSB), represents 902.5 MHz, and each LSB represents an increase of 0.5 MHz. The maximum setting, 110010 (binary for 50 LSB), selects a channel frequency of 927.5 MHz.
[7:5]	Not used (don't care).
[4:0]	Transmission power setting. This is a 5-bit, offset binary number that selects the transmission power in the gateway node. The lowest setting, 00000 (binary for 0 LSB), selects a transmission power of −15.5 dBm, and each LSB increases the transmission power by +1.7 dBm. The maximum setting, 01111, selects a transmission power of 10 dBm.

Wireless Configuration

The RF_MODE register (see Table 20) provides a number of important wireless configuration parameters. Note that when the transmission power exceeds −1 dBm and the update period is less than 10 seconds, FCC Part 15.247 requires the use of frequency hopping.

Table 20. RF_MODE,
Page 1 to Page 6, Low Byte Address = 0x5C, Read/Write

Bits	Description (Default = 0x0000)
[15:12]	Not used (don't care)
[11]	Continuous transmission mode (single-channel, per TX_PWR_CTRL_S, see Table 19)
[10]	Continuous frequency hopping mode
[9:7]	Not used (don't care)
[6]	Frequency hopping (0 = disable, 1 = enable)
[5:2]	Not used (don't care)
[1]	Update gateway on alarm only (0 = disable, 1 = enable)
[0]	Not used (don't care)

The UPDAT_INT and INT_SCL registers (see Table 21 and Table 22) establish the time between wake-up events, where the remote ADIS16229 captures data, analyzes it, and communicates the information.

Table 21. UPDAT_INT,
Page 1 to Page 6, Low Byte Address = 0x5E, Read/Write

Bits	Description (Default = 0x0FA0)
[15:0]	Offset binary number, scale factor set by INT_SCL register

Table 22. INT_SCL,
Page 1 to Page 6, Low Byte Address = 0x60, Read/Write

Bits	Description (Default = 0x0001)
[15:2]	Not used (don't care)
[1:0]	Scale factor
	00 = 30.52 μs/LSB, maximum = 2 seconds
	01 = 0.488 ms/LSB, maximum = 31.98 seconds
	10 = 1/128 sec/LSB, maximum = 512 seconds
	11 = 1 sec/LSB, maximum = 18.2 hours

The TEST_MODE register (see Table 23) provides specific test modes for FCC testing.

Table 23. TEST_MODE,
Page 0, Low Byte Address = 0x10, Read/Write

Bits	Description (Default = 0x0000)
[15:12]	Not used
11	Continuous transmission mode (single-channel, per TX_PWR_CTRL_G, see Table 18)
10	Continuous frequency hopping mode
[9:0]	Not used

Communication Tools

The PKT_TIME_H (upper word) and PKT_TIME_L (lower word) registers provide a 32-bit timer for tracking the relative times associated with packet transmission times. When the timer reaches its maximum value of 0xFFFFFFFF, it automatically starts over at 0x00000000.

Table 24. PKT_TIME_L,
Page 1 to Page 6, Low Byte Address = 0x52, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Offset binary number, lower word, 1 LSB = 0.488 ms

Table 25. PKT_TIME_H,
Page 1 to Page 6, Low Byte Address = 0x54, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Offset binary number, upper word

The NW_ERROR_STAT register (see Table 26) provides all of the error flags associated with the wireless communication.

Table 26. NW_ERROR_STAT,
Page 0, Low Byte Address = 0x06, Read Only

Bits	Description (Default = 0x0000)
[15:11]	Not used
10	Invalid packet received
9	Received packet from an unknown device
8	Packet synchronization failure from the most recent received packet
[7:6]	Not used
5	Packet length mismatch
4	Missing packet
3	Packets received out of sync
2	Failure to receive acknowledgment from a sensor node
1	Low signal strength from a sensor node, read RSSI_S register for power level of this signal (see Table 17)
0	CRC mismatch error associated with the most recent packet from the sensor node packet

Table 27. PKT_ERROR_STAT,
Page 1 to Page 6, Low Byte Address = 0x56, Read Only

Bits	Description (Default = 0x0000)
[15:10]	Not used
9	Received packet from an unknown device
8	Packet synchronization failure from the most recent received packet
[7:6]	Not used
5	Packet length mismatch
4	Missing packet
3	Packets received out of sync
2	Failure to receive acknowledgment from a sensor node
1	Low signal strength from a sensor node, read RSSI_S register for power level of this signal (see Table 17)
0	CRC mismatch error associated with the most recent packet from the sensor node packet

SENSOR NODE RECORDING MODE AND SIGNAL PROCESSING

The ADIS16229 provides a complete sensing system for recording and monitoring vibration data. Figure 17 provides a simplified block diagram for the signal processing associated with spectral record acquisition on both axes (x and y). User registers provide controls for data type (time or frequency), trigger mode (manual or automatic), collection mode (real time or capture), sample rates and filtering, windowing, FFT averaging, spectral alarms, and input/output management.

RECORDING MODE

The recording mode selection establishes the data type (time or frequency domain), trigger type (manual or automatic), and data collection (captured or real time). The REC_CTRL1[1:0] bits (see Table 28) provide four operating modes: manual FFT, automatic FFT, manual time capture, and real time. After REC_CTRL1 is set, the manual FFT, automatic FFT, and manual time capture modes require a start command to start acquiring a spectral or time domain record. All of these modes automatically trigger when the sensor receives the configuration packet from the gateway. Set GLOB_CMD_S[11] = 1 to halt the operation and wait for further instructions from the ADIS16000.

Manual FFT Mode

Set REC_CTRL1[1:0] = 00 to place the device in manual FFT mode, which triggers a single FFT cycle. When the spectral record is complete, the device transmits the data to the ADIS16000 and waits for another start command.

Automatic FFT Mode

Set REC_CTRL1[1:0] = 01 to place the device in automatic FFT mode. Use the UPDAT_INT and INT_SCL registers to establish the period between wake-up times, which triggers data capture, FFT computation, and analysis.

Manual Time Capture Mode

Set REC_CTRL1[1:0] = 10 to place the device into manual time capture mode, which results in triggering a single time domain data capture. When the device operates in this mode, 512 samples of time domain data are loaded into the buffer for each axis.

This data goes through all time domain signal processing, except the preFFT windowing, prior to loading into the data buffer for user access. When the data record is complete, the device transmits the data to the ADIS16000 and waits for another start command.

Real-Time Mode

Set REC_CTRL1[1:0] = 11 to place the device into real-time mode. In this mode, the device samples only one axis, at a rate of 5 kSPS, and provides data on its output register at the SR0 sample rate setting in AVG_CNT[3:0] (see Table 29). Select the axis of measurement in this mode by reading its assigned register. For example, select the x-axis by reading X_BUF, using DIN = 0x0600. See Table 60 or Table 61 for more information on the x_BUF registers. No other ADIS16229 nodes are able to communicate with the ADIS16000 when one of the ADIS16229 nodes is in real-time mode.

Table 28. REC_CTRL1,
Page 1 to Page 6, Low Byte Address = 0x1A, Read/Write

| Bits	Description (Default = 0x1102)
[15:14]	Not used (don't care)
[13:12]	Window setting; 00 = rectangular, 01 = Hanning, 10 = flat top, 11 = N/A[1]
11	SR3: 1 = enabled for FFT, 0 = disabled; Sample rate = $20{,}000 \div 2^{AVG\_CNT[15:12]}$ (see Table 29)
10	SR2: 1 = enabled for FFT, 0 = disabled; Sample rate = $20{,}000 \div 2^{AVG\_CNT[11:8]}$ (see Table 29)
9	SR1: 1 = enabled for FFT, 0 = disabled; Sample rate = $20{,}000 \div 2^{AVG\_CNT[7:4]}$ (see Table 29)
8	SR0: 1 = enabled for FFT, 0 = disabled; Sample rate = $20{,}000 \div 2^{AVG\_CNT[3:0]}$ (see Table 29)
7	Power-down between each recording, 1 = enabled
[6:4]	Not used (don't care)
[3:2]	Storage method; 00 = none, 01 = alarm trigger, 10 = all, 11 = N/A[1]
[1:0]	Recording mode; 00 = manual FFT, 01 = automatic FFT, 10 = manual time capture, 11 = real-time sampling/data access

[1] N/A = not applicable.
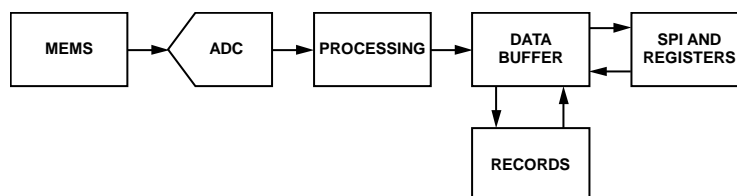
Figure 17. Simplified Block Diagram

SPECTRAL RECORD PRODUCTION

The ADIS16229 produces a spectral record by taking a time record of data on both axes, then scaling, windowing, and performing an FFT process on each time record. This process is repeated for a programmable number of FFT averages, with the FFT result of each cycle accumulating in the data buffer. After completing the selected number of cycles, the FFT averaging process completes by scaling the data buffer contents. Then the data buffer contents are available to the SPI and output data registers.

SAMPLE RATE AND FILTERING

The sample rate for each axis is 20 kSPS. The internal ADC samples both axes in a time-interleaving pattern (x1, y1, x2, y2, and so on) that provides even distribution of data across the data record. The averaging/decimating filter provides a control for the final sample rate in the time record. By averaging and decimating the time domain data, this filter provides the ability to focus the spectral record on lower bandwidths, producing finer frequency resolution in each FFT frequency bin. The AVG_CNT register (see

Table 29) provides the settings for the four different sample rate options in REC_CTRL1[11:8] (SRx in Table 28). All four options are available when using the manual FFT, automatic FFT, and manual time capture modes. When more than one sample rate option is enabled while the device is in one of the manual modes, the device produces a spectral record for one SRx at a time, starting with the lowest number. After completing the spectral record for one SRx option, the device waits for another start command before producing a spectral record for the next SRx option that is enabled in REC_CTRL1[11:8]. When more than one sample rate option is enabled while the device is in the automatic FFT mode, the device produces a spectral record for one SRx option and then waits for the next automatic trigger, which occurs based on the UPDAT_INT and INT_SCL registers (see Table 21 and Table 22). See Figure 19 for more details on how multiple SRx options influence data collection and spectral record production. When real-time mode is used, the output data rate reflects the SR0 setting.
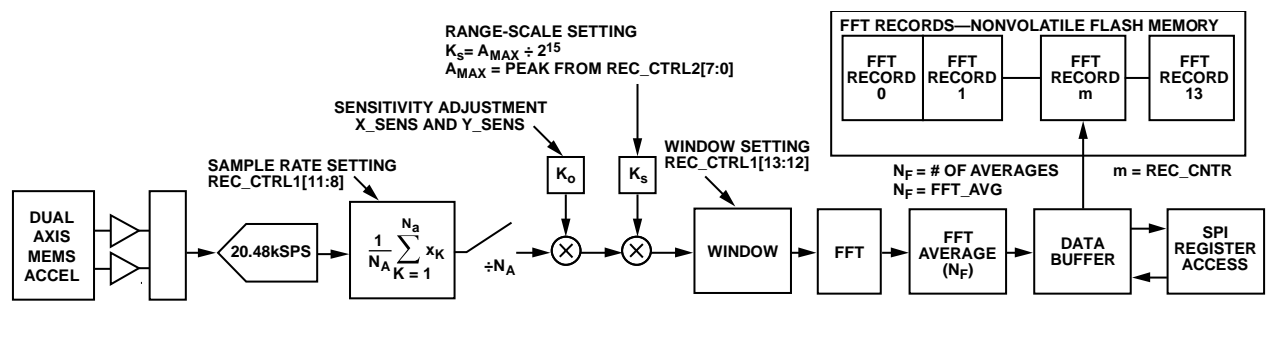

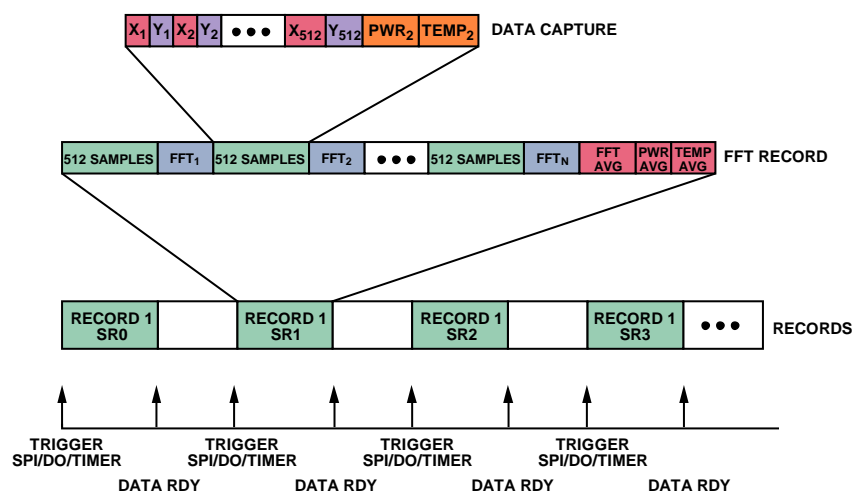Figure 18. Signal Flow Diagram, REC_CTRL1[1:0] = 00 or 01, FFT Analysis Modes

Figure 19. Spectral Record Production, with All SRx Settings Enabled

Table 30 provides a list of SRx settings available in the AVG_CNT register (see Table 29), along with the resulting sample rates, FFT bin widths, bandwidth, and estimated total noise. Note that each SRx setting also has associated range settings in the REC_CTRL2 register (see Table 31) and the FFT averaging settings that are shown in the FFT_AVG1 and FFT_AVG2 registers (see Table 35 and Table 36, respectively).

Table 29. AVG_CNT,
Page 1 to Page 6, Low Byte Address = 0x32, Read/Write

Bits	Description (Default = 0x9630)
[15:12]	Sample Rate Option 3 (SR3), binary (0 to 10), SR3 option sample rate = $20,000 \div 2^{AVG\_CNT[15:12]}$
[11:8]	Sample Rate Option 2 (SR2), binary (0 to 10), SR2 option sample rate = $20,000 \div 2^{AVG\_CNT[11:8]}$
[7:4]	Sample Rate Option 1 (SR1), binary (0 to 10), SR1 option sample rate = $20,000 \div 2^{AVG\_CNT[7:4]}$
[3:0]	Sample Rate Option 0 (SR0), binary (0 to 10), SR0 option sample rate = $20,000 \div 2^{AVG\_CNT[3:0]}$

Table 30. Sample Rate Settings and Filter Performance

SRx Setting	Sample Rate, f_S (SPS)	Bin Width (Hz)	Bandwidth (Hz)
0	20,000	39.1	10,000
1	10,000	19.5	5,000
2	5,000	9.8	2,500
3	2,500	4.9	1,250
4	1,250	2.4	625
5	625	1.2	313
6	313	0.6	156
7	156	0.3	78
8	78	0.2	39
9	39	0.1	20
10	20	0.0	10

DYNAMIC RANGE AND SENSITIVITY

The range of the ADIS16229 accelerometers depends on the frequency of the vibration. The accelerometers have a self-resonant frequency of 5.5 kHz, and the signal conditioning circuit applies a single-pole, low-pass filter (2.5 kHz) to the response. The self-resonant behavior of the accelerometer influences the relationship between vibration frequency and dynamic range. Figure 20 displays the response to peak input amplitudes, assuming a sinusoidal vibration signature at each frequency. The accelerometer resonance and low-pass filter also influence the magnitude response, as shown in Figure 21.
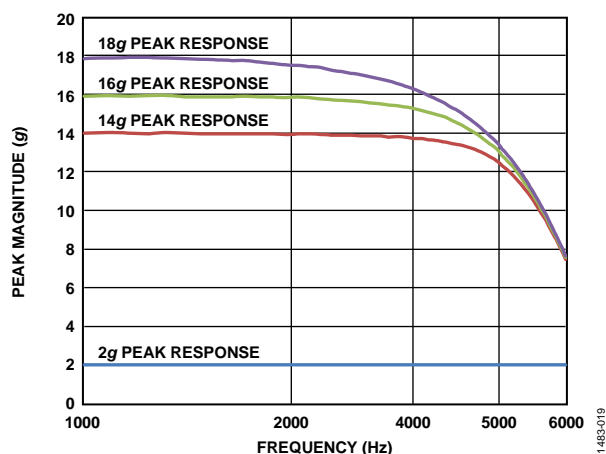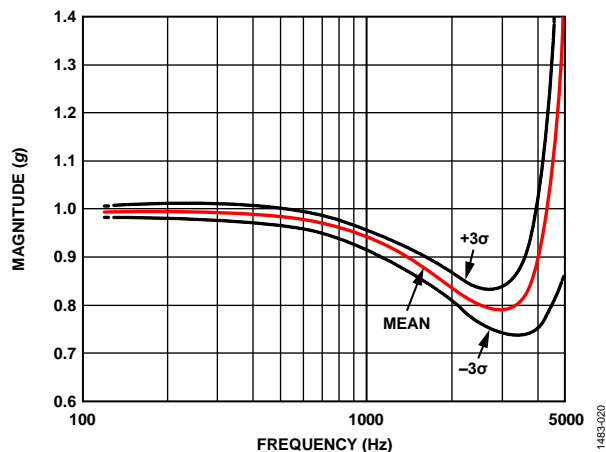

Figure 20. Peak Magnitude vs. Frequency

Figure 21. Magnitude/Frequency Response

DYNAMIC RANGE SETTINGS

REC_CTRL2 (see Table 31) provides four range settings that are associated with each sample rate option, SRx. The range options referenced in REC_CTRL2 reflect the maximum dynamic range, which occurs at the lower part of the frequency range and does not account for the decrease in range (see Figure 20). For example, set REC_CTRL2[5:4] = 10 (DIN = 0x9C20) to set the peak acceleration (A_{MAX}) to 10 g on the SR2 sample rate option. These settings optimize FFT precision and sensitivity when monitoring lower magnitude vibrations. For each range setting in Table 31, this stage scales the time domain data so that the maximum value equates to 2^{15} LSBs for time domain data and 2^{16} LSBs for frequency domain data.

Note that the maximum range for each setting is 1 LSB smaller than the listed maximum. For example, the maximum number of codes in the frequency domain analysis is $2^{16} - 1$, or 65,535. When using a range setting of 1 g in one of the FFT modes, the maximum measurement is equal to 1 g times $2^{16} - 1$, divided by 2^{16}. See Table 32 for the resolution associated with each setting and Figure 18 for the location of this operation in the signal flow diagram. The real-time mode automatically uses the 20 g range setting.

Table 31. REC_CTRL2,
Page 1 to Page 6, Low Byte Address = 0x1C, Read/Write

Bits	Description (Default = 0x00FF)
[15:8]	Not used (don't care)
[7:6]	Measurement range, SR3; 11 = 1 g, 10 = 5 g, 01 = 10 g, 00 = 20 g
[5:4]	Measurement range, SR2; 11 = 1 g, 10 = 5 g, 01 = 10 g, 00 = 20 g
[3:2]	Measurement range, SR1; 11 = 1 g, 10 = 5 g, 01 = 10 g, 00 = 20 g
[1:0]	Measurement range, SR0; 11 = 1 g, 10 = 5 g, 01 = 10 g, 00 = 20 g

Table 32. Range Settings and LSB Weights

Range Setting (g)	Time Mode (mg/LSB)	FFT Mode (mg/LSB)
0 to 1	0.0305	0.0153
0 to 5	0.1526	0.0763
0 to 10	0.3052	0.1526
0 to 20	0.6104	0.3052

Scale Adjustment

The x_SENS registers (see Table 33 and Table 34) provide a fine-scale adjustment function for each axis. The following equation describes how to use measured and ideal values to calculate the scale factor for each register in LSBs:

$$SCFx = \left[a_{XI} \Big/ a_{XM} - 1 \right] \times 2^{18}$$

where:
a_{XI} is the ideal x-axis value.
a_{XM} is the actual x-axis measurement.

These registers contain correction factors, which come from the factory calibration process. The calibration process records accelerometer output in four different orientations and computes the correction factors for each register.

These registers also provide write access for in-system adjustment. Gravity provides a common stimulus for this type of correction process. Use both +1 g and −1 g orientations to reduce the effect of offset on this measurement. In this case, the ideal measurement is 2 g, and the measured value is the difference of the accelerometer measurements at +1 g and −1 g orientations. The factory-programmed values are stored in flash memory and are restored by setting GLOB_CMD_S[3] = 1 (DIN = 0xB604). See Table 75.

Table 33. X_SENS,
Page 1 to Page 6, Low Byte Address = 0x16, Read/Write

Bits	Description (Default = Not Applicable)
[15:0]	X-axis scale correction factor (SCFx), twos complement

Table 34. Y_SENS,
Page 1 to Page 6, Low Byte Address = 0x18, Read/Write

Bits	Description (Default = Not Applicable)
[15:0]	Y-axis scale correction factor (SCFy), twos complement

PREFFT WINDOWING

REC_CTRL1[13:12] provides three options for preFFT windowing of time data. For example, set REC_CTRL1[13:12] = 01 to use the Hanning window, which offers the best amplitude resolution of the peaks between frequency bins and minimal broadening of peak amplitudes. The rectangular and flat top windows are also available because they are common windowing options for vibration monitoring. The flat top window provides accurate amplitude resolution with a trade-off of broadening the peak amplitudes.

FFT

The FFT process converts each 512-sample time record into a 256-point spectral record that provides magnitude vs. frequency data.

FFT AVERAGING

The FFT averaging function combines multiple FFT records to reduce the variation of the FFT noise floor, enabling detection of lower vibration levels. Each SRx option in the REC_CTRL1 register has its own FFT average control, which establishes the number of FFT records to average into the final FFT record. To enable this function, write the number of averages for each SRx option that is enabled in the REC_CTRL1 register to the FFT_AVGx registers. For example, set FFT_AVG2[15:8] = 0x10 (DIN = 0x9110) to set the number of FFT averages to 16 for the SR3 sample rate option.

Table 35. FFT_AVG1,
Page 1 to Page 6, Low Byte Address = 0x0E, Read/Write

Bits	Description (Default = 0x0108)
[15:8]	FFT averages for a single record, SR1 sample rate, N_F in Figure 18; range = 1 to 255, binary
[7:0]	FFT averages for a single record, SR0 sample rate, N_F in Figure 18; range = 1 to 255, binary

Table 36. FFT_AVG2,
Page 1 to Page 6, Low Byte Address = 0x10, Read/Write

Bits	Description (Default = 0x0101)
[15:8]	FFT averages for a single record, SR3 sample rate, N_F in Figure 18; range = 1 to 255, binary
[7:0]	FFT averages for a single record, SR2 sample rate, N_F in Figure 18; range = 1 to 255, binary

RECORDING TIMES

When using automatic FFT mode, the automatic recording period (UPDAT_INT, see Table 21) must be greater than the total recording time. Use the following equations to calculate the recording time:

Manual time mode

$$t_R = t_S + t_{PT} + t_{ST} + t_{AST}$$

FFT modes

$$t_R = N_F \times (t_S + t_{PT} + t_{FFT}) + t_{ST} + t_{AST}$$

Table 37 provides a list of the processing times and settings used in these equations.

Table 37. Typical Processing Times

Function	Time (ms)
Sample Time, t_S	$1 \div f_S$, per AVG_CNT
Processing Time, t_{PT}	18.7
Storage Time, t_{ST}	120.0
Alarm Scan Time, t_{AST}	2.21
Number of FFT Averages, N_F	Per FFT_AVG1, FFT_AVG2
FFT Time, t_{FFT}	32.7

The storage time (t_{ST}) applies only when a storage method is selected in REC_CTRL1[3:2] (see Table 28 for more details about the record storage settings). The alarm scan time (t_{AST})

applies only when the alarms are enabled in ALM_CTRL[3:0] (see Table 42 for more information). For systems that cannot use DO1 to monitor the status of these operations, understanding the recording time helps predict when data is available. Note that when using automatic FFT mode, the automatic recording period (UPDAT_INT, see Table 21) must be greater than the total recording time.

DATA RECORDS

After the ADIS16229 finishes processing the FFT data, it stores the data into the data buffer, where it is available for external access using the SPI and x_BUF registers (see Table 60 and Table 61). REC_CTRL1[3:2] (see Table 28) provides programmable conditions for writing buffer data into the FFT records, which are in nonvolatile flash memory locations. Set REC_CTRL1[3:2] = 01 to store buffer data into the flash memory records only when an alarm condition is met. Set REC_CTRL1[3:2] = 10 to store every set of FFT data into the flash memory locations. The flash memory record provides space for a total of 14 records. Each record stored in flash memory contains a header and frequency domain (FFT) data from both axes, x and y. When all 14 records are full, new records do not load into the flash memory. The REC_CNTR register (see Table 38) provides a running count for the number of records that are stored. Set GLOB_CMD_S[8] = 1 (DIN = 0xB701) to clear all of the records in flash memory.

Table 38. REC_CNTR,
Page 1 to Page 6, Low Byte Address = 0x50, Read Only

Bits	Description (Default = 0x0000)
[15:5]	Not used
[4:0]	Total number of records taken; range = 0 to 13, binary

When used in conjunction with automatic trigger mode and record storage, FFT analysis for each sample rate option requires no additional inputs. Depending on the number of FFT averages, the time between each sample rate selection may be quite large. Note that selecting multiple sample rates reduces the number of records available for each sample rate setting, as shown in Table 39.

Table 39. Available Records per Sample Rate Selected

Number of Sample Rates Selected	Available Records
1	14
2	7
3	4
4	3

FFT RECORD FLASH ENDURANCE

The REC_FLSH_CNT register (see Table 40) increments when all 14 records contain FFT data.

Table 40. REC_FLSH_CNT,
Page 1 to Page 6, Low Byte Address = 0x4A, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Flash write cycle count; record data only, binary

SENSOR NODE SPECTRAL ALARMS

The alarm function offers six spectral bands for alarm detection. Each spectral band has high and low frequency definitions, along with two different trigger thresholds (Alarm 1 and Alarm 2) for each accelerometer axis. Table 41 provides a summary of each register used to configure the alarm function.

Table 41. Alarm Function Register Summary

Register	Address	Description
ALM_F_LOW	0x20	Alarm frequency band, lower limit
ALM_F_HIGH	0x22	Alarm frequency band, upper limit
ALM_X_MAG1	0x24	X-axis Alarm Trigger Level 1 (warning)
ALM_Y_MAG1	0x26	Y-axis Alarm Trigger Level 1 (warning)
ALM_X_MAG2	0x28	X-axis Alarm Trigger Level 2 (fault)
ALM_Y_MAG2	0x2A	Y-axis Alarm Trigger Level 2 (fault)
ALM_PNTR	0x2C	Alarm pointer
ALM_S_MAG	0x2E	System alarm trigger level
ALM_CTRL	0x30	Alarm configuration
DIAG_STAT_S	0x34	Alarm status
ALM_X_STAT	0x38	X-axis alarm status
ALM_Y_STAT	0x3A	Y-axis alarm status
ALM_X_PEAK	0x3C	X-axis alarm peak
ALM_Y_PEAK	0x3E	Y-axis alarm peak
ALM_X_FREQ	0x44	X-axis alarm frequency of peak alarm
ALM_Y_FREQ	0x46	Y-axis alarm frequency of peak alarm

The ALM_CTRL register (see Table 42) provides control bits that enable the spectral alarms of each axis, configures the system alarm, sets the record delay for the spectral alarms, and configures the clearing function for the DIAG_STAT_S error flags (see Table 86).

Table 42. ALM_CTRL,
Page 1 to Page 6, Low Byte Address = 0x30, Read/Write

Bits	Description (Default = 0x0080)
[15:12]	Not used.
[11:8]	Response delay; range = 0 to 15. Represents the number of spectral records for each spectral alarm before a spectral alarm flag is set high.
7	Latch DIAG_STAT_S error flags. Requires a clear status command (GLOB_CMD_S[4]) to reset the flags to 0. 1 = enabled, 0 = disabled.
6	Enable DO1 as an Alarm 1 output indicator and enable DO2 as an Alarm 2 output indicator. 1 = enabled, 0 = disabled.
5	System alarm comparison polarity. 1 = trigger when less than ALM_S_MAG[15:0]. 0 = trigger when greater than ALM_S_MAG[15:0].
4	System alarm. 1 = temperature, 0 = power supply.
3	Alarm S enable (ALM_S_MAG). 1 = enabled, 0 = disabled.
2	Not used.
1	Alarm Y enable (ALM_Y_MAG). 1 = enabled, 0 = disabled.
0	Alarm X enable (ALM_X_MAG). 1 = enabled, 0 = disabled.

ALARM DEFINITION

The alarm function provides six programmable spectral bands, as shown in Figure 22. Each spectral alarm band has lower and upper frequency definitions for all of the sample rate options (SRx). It also has two independent trigger level settings, which are useful for systems that value warning and fault condition indicators.
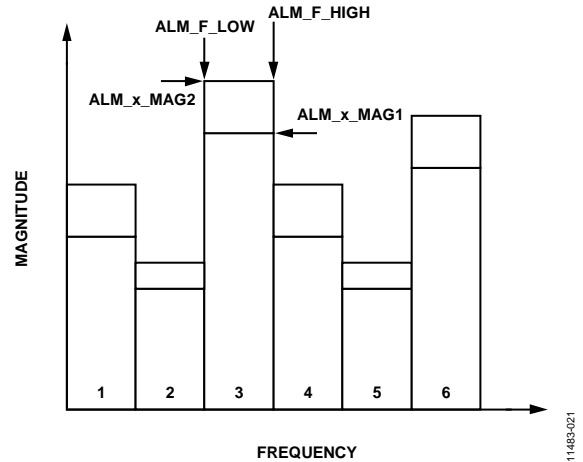
Figure 22. Spectral Band Alarm Setting Example, ALM_PNTR = 0x03

Select the spectral band for configuration by writing its number (1 to 6) to ALM_PNTR[2:0] (see Table 43). Then select the sample rate option using ALM_PNTR[9:8]. This number represents a binary number, which corresponds to the x in the SRx sample rates option associated with REC_CTRL1[11:8] (see Table 28). For example, set ALM_PNTR[7:0] = 0x05 (DIN = 0xAC05) to select Alarm Spectral Band 5, and set ALM_PNTR[15:8] = 0x02 (DIN = 0xAC02) to select the SR2 sample rate option.

Table 43. ALM_PNTR,
Pages 1 to 6, Low Byte Address = 0x2C, Read/Write

Bits	Description (Default = 0x0000)
[15:10]	Not used
[9:8]	Sample rate option; range = 0 to 3 for SR0 to SR3
[7:3]	Not used
[2:0]	Spectral band number; range = 1 to 6

Alarm Band Frequency Definitions

After the spectral band and sample rate settings are set, program the lower and upper frequency boundaries by writing their bin numbers to the ALM_F_LOW register (see Table 44) and ALM_F_HIGH register (see Table 45). Use the bin width definitions listed in Table 30 to convert a frequency into a bin number for this definition. Calculate the bin number by dividing the frequency by the bin width associated with the sample rate setting. For example, if the sample rate is 5000 Hz and the lower band frequency is 400 Hz, divide that number by the bin width of 10 Hz to arrive at the 40th bin as the lower band setting. Then set ALM_F_LOW[7:0] = 0x28 (DIN = 0xA028) to establish 400 Hz as the lower frequency for the 5000 SPS sample rate setting.

Table 44. ALM_F_LOW,
Page 1 to Page 6, Low Byte Address = 0x20, Read/Write

Bits	Description (Default = 0x0000)
[15:8]	Not used
[7:0]	Lower frequency, bin number; range = 0 to 255

Table 45. ALM_F_HIGH,
Page 1 to Page 6, Low Byte Address = 0x22, Read/Write

Bits	Description (Default = 0x0000)
[15:8]	Not used
[7:0]	Upper frequency, bin number; range = 0 to 255

Alarm Trigger Settings

The ALM_x_MAG1 and ALM_x_MAG2 registers (see Table 46 to Table 49) provide two independent trigger settings for both axes of acceleration data. They use the data format established by the range settings in the REC_CTRL2 register (see Table 31) and recording mode in REC_CTRL1[1:0] (see Table 28). For example, when using the 0 *g* to 1 *g* mode for FFT analysis, 32,768 LSB is the closest setting to 500 m*g*. Therefore, set ALM_Y_MAG2 = 0x8000 (DIN = 0xAB80, 0xAA00) to set the critical alarm to 500 m*g*, when using the 0 *g* to 1 *g* range option in REC_CTRL2 for FFT records. See Table 31 and Table 32 for more information about formatting each trigger level. Note that the trigger settings associated with Alarm 2 must be greater than the trigger settings for Alarm 1. In other words, the alarm magnitude settings must meet the following criteria:

ALM_X_MAG2 > ALM_X_MAG1
ALM_Y_MAG2 > ALM_Y_MAG1

Table 46. ALM_X_MAG1,
Page 1 to Page 6, Low Byte Address = 0x24, Read/Write

Bits	Description (Default = 0x0000)
[15:0]	X-Axis Alarm Trigger Level 1, 16-bit unsigned (see Table 31 and Table 32 for the scale factor)

Table 47. ALM_Y_MAG1,
Page 1 to Page 6, Low Byte Address = 0x26, Read/Write

Bits	Description (Default = 0x0000)
[15:0]	Y-Axis Alarm Trigger Level 1, 16-bit unsigned (see Table 31 and Table 32 for the scale factor)

Table 48. ALM_X_MAG2,
Page 1 to Page 6, Low Byte Address = 0x28, Read/Write

Bits	Description (Default = 0x0000)
[15:0]	X-Axis Alarm Trigger Level 2, 16-bit unsigned (see Table 31 and Table 32 for the scale factor)

Table 49. ALM_Y_MAG2,
Page 1 to Page 6, Low Byte Address = 0x2A, Read/Write

Bits	Description (Default = 0x0000)
[15:0]	Y-Axis Alarm Trigger Level 2, 16-bit unsigned (see Table 31 and Table 32 for the scale factor)

Table 50. ALM_S_MAG,
Page 1 to Page 6, Low Byte Address = 0x2E, Read/Write

Bits	Description (Default = 0x0000)
[15:0]	System alarm trigger level, data format matches target from ALM_CTRL[4] (see Table 42)

Enable Alarm Settings

Before configuring the spectral alarm registers, clear their current contents by setting GLOB_CMD_S[9] = 1 (DIN = 0xB702). After completing the spectral alarm band definitions, save the settings by setting GLOB_CMD_S[12] = 1 (DIN = 0xB710). The device ignores the save command if any of these locations has already been written to.

ALARM INDICATOR SIGNALS

GPO_CTRL[5:0] (see Table 84) and ALM_CTRL[6] (see Table 42) provide controls for establishing DO1 and DO2 as dedicated alarm output indicator signals. Use GPO_CTRL[5:0] to select the alarm function for DO1 and/or DO2, then set ALM_CTRL[6] = 1 to enable DO1 to serve as an Alarm 1 indicator and DO2 as an Alarm 2 indicator. This setting establishes DO1 to indicate Alarm 1 (warning) conditions and DO2 to indicate Alarm 2 (critical) conditions.

ALARM FLAGS AND CONDITIONS

The FFT header (see Table 70) contains both generic alarm flags (DIAG_STAT_S, see Table 86) and spectral band-specific alarm flags (ALM_x_STAT, see Table 51 and Table 52). The FFT header also contains magnitude (ALM_x_PEAK, see Table 53 and Table 54) and frequency information (ALM_x_FREQ, see Table 55 and Table 56) associated with the highest magnitude of vibration content in the record.

ALARM STATUS

The ALM_x_STAT registers (see Table 51 and Table 52) provide alarm bits for each spectral band on the current sample rate option.

Table 51. ALM_X_STAT,
Page 1 to Page 6, Low Byte Address = 0x38, Read Only

Bits	Description (Default = 0x0000)
15	Alarm 2 on Band 6; 1 = alarm set, 0 = no alarm
14	Alarm 1 on Band 6; 1 = alarm set, 0 = no alarm
13	Alarm 2 on Band 5; 1 = alarm set, 0 = no alarm
12	Alarm 1 on Band 5; 1 = alarm set, 0 = no alarm
11	Alarm 2 on Band 4; 1 = alarm set, 0 = no alarm
10	Alarm 1 on Band 4; 1 = alarm set, 0 = no alarm
9	Alarm 2 on Band 3; 1 = alarm set, 0 = no alarm
8	Alarm 1 on Band 3; 1 = alarm set, 0 = no alarm
7	Alarm 2 on Band 2; 1 = alarm set, 0 = no alarm
6	Alarm 1 on Band 2; 1 = alarm set, 0 = no alarm
5	Alarm 2 on Band 1; 1 = alarm set, 0 = no alarm
4	Alarm 1 on Band 1; 1 = alarm set, 0 = no alarm
3	Not used
[2:0]	Most critical alarm condition, spectral band; range = 1 to 6

Table 52. ALM_Y_STAT,
Page 1 to Page 6, Low Byte Address = 0x3A, Read Only

Bits	Description (Default = 0x0000)
15	Alarm 2 on Band 6; 1 = alarm set, 0 = no alarm
14	Alarm 1 on Band 6; 1 = alarm set, 0 = no alarm
13	Alarm 2 on Band 5; 1 = alarm set, 0 = no alarm
12	Alarm 1 on Band 5; 1 = alarm set, 0 = no alarm
11	Alarm 2 on Band 4; 1 = alarm set, 0 = no alarm
10	Alarm 1 on Band 4; 1 = alarm set, 0 = no alarm
9	Alarm 2 on Band 3; 1 = alarm set, 0 = no alarm
8	Alarm 1 on Band 3; 1 = alarm set, 0 = no alarm
7	Alarm 2 on Band 2; 1 = alarm set, 0 = no alarm
6	Alarm 1 on Band 2; 1 = alarm set, 0 = no alarm
5	Alarm 2 on Band 1; 1 = alarm set, 0 = no alarm
4	Alarm 1 on Band 1; 1 = alarm set, 0 = no alarm
3	Not used
[2:0]	Most critical alarm condition, spectral band; range = 1 to 6

WORST-CASE CONDITION MONITORING

The ALM_x_PEAK registers (see Table 53 and Table 54) contain the peak magnitude for the worst-case alarm condition in each axis. The ALM_x_FREQ registers (see Table 55 and Table 56) contain the frequency bin number for the worst-case alarm condition.

Table 53. ALM_X_PEAK,
Page 1 to Page 6, Low Byte Address = 0x3C, Read Only

Bits	Description (Default = 0x0000)
[15:0]	Alarm peak, x-axis, accelerometer data format

Table 54. ALM_Y_PEAK,
Page 1 to Page 6, Low Byte Address = 0x3E, Read Only

Bits	Description (Default = 0x0000)
[15:0]	Alarm peak, y-axis, accelerometer data format

Table 55. ALM_X_FREQ,
Page 1 to Page 6, Low Byte Address = 0x44, Read Only

Bits	Description (Default = 0x0000)
[15:8]	Not used
[7:0]	Alarm frequency of x-axis peak alarm level, FFT bin number; range = 0 to 255

Table 56. ALM_Y_FREQ,
Page 1 to Page 6, Low Byte Address = 0x46, Read Only

Bits	Description (Default = 0x0000)
[15:8]	Not used
[7:0]	Alarm frequency of y-axis peak alarm level, FFT bin number; range = 0 to 255

READING OUTPUT DATA

After the ADIS16229 updates the ADIS16000 with its data, the data is available in the data buffer and FFT records, if selected. In manual time capture mode, the record for each axis contains 512 samples. In manual and automatic FFT mode, each record contains the 256-point FFT result for each accelerometer axis. Table 57 provides a summary of registers that provide access to processed sensor data.

Table 57. Output Data Registers (Sensor Nodes)

Register	Address	Description
TEMP_OUT_S	0x0A	Internal temperature
SUPPLY_OUT_S	0x0C	Power supply
BUF_PNTR	0x12	Data buffer index pointer
REC_PNTR	0x14	FFT record index pointer
X_BUF	0x06	X-axis accelerometer data
Y_BUF	0x08	Y-axis accelerometer data
GLOB_CMD_S	0x36	FFT record retrieve command
TIME_STMP_L	0x40	Time stamp, lower word
TIME_STMP_H	0x42	Time stamp, upper word
REC_INFO1	0x4C	FFT record header information
REC_INFO2	0x4E	FFT record header information

READING DATA FROM THE DATA BUFFER

After completing a spectral record and updating each data buffer, the ADIS16000 loads the first data sample from each data buffer into the x_BUF registers (see Table 60 and Table 61) and sets the buffer index pointer in the BUF_PNTR register (see Table 58) to 0x0000. The index pointer determines which data samples load into the x_BUF registers. For example, writing 0x009F to the BUF_PNTR register (DIN = 0x9300, DIN = 0x929F) causes the 160th sample in each data buffer location to load into the x_BUF registers. The index pointer increments with every x_BUF read command, which causes the next set of capture data to load into each capture buffer register automatically. This enables an efficient method for reading all 256 samples in a record, using sequential read commands, without having to manipulate the BUF_PNTR register.
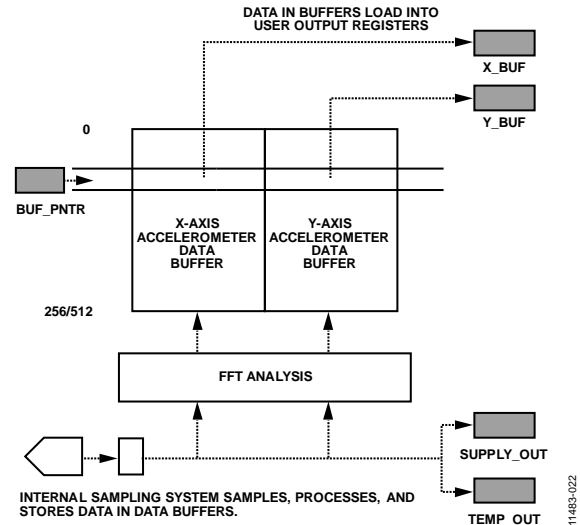

Figure 23. Data Buffer Structure and Operation

Table 58. BUF_PNTR,
Page 1 to Page 6, Low Byte Address = 0x12, Read/Write

Bits	Description (Default = 0x0000)
[15:9]	Not used
[8:0]	Data bits; range = 0 to 255 (FFT), 0 to 511 (time)

ACCESSING FFT RECORD DATA

The FFT records can be stored in flash memory. The REC_PNTR register (see Table 59) and GLOB_CMD_S[13] (see Table 75) provide access to the FFT records, as shown in Figure 24. For example, set REC_PNTR[7:0] = 0x0A (DIN = 0x940A) and GLOB_CMD_S[13] = 1 (DIN = 0xB720) to load FFT Record 10 in the FFT buffer for SPI/register access.

Table 59. REC_PNTR,
Page 1 to Page 6, Low Byte Address = 0x14, Read/Write

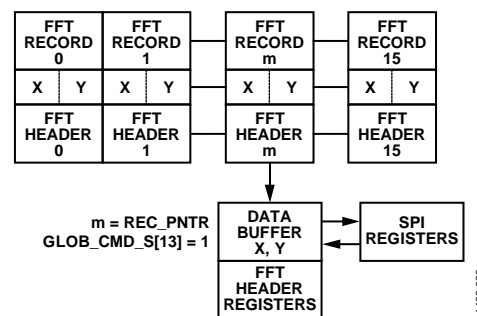| Bits	Description (Default = 0x0000)
[15:4]	Not used (don't care)
[3:0]	Data bits

Figure 24. FFT Record Access

DATA FORMAT

Table 60 and Table 61 list the bit assignments for the x_BUF registers. The acceleration data format depends on the range scale setting in REC_CTRL2 (see Table 31) and the recording mode settings in REC_CTRL1 (see Table 28). Table 62 provides some data formatting examples for the FFT mode, and Table 63 offers some data formatting examples for the 16-bit, twos complement format used in manual time mode.

Table 60. X_BUF,
Page 1 to Page 6, Low Byte Address = 0x06, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Buffer for x-axis acceleration data
	See Table 32 for scale sensitivity
	Format = twos complement (time), binary (FFT)

Table 61. Y_BUF,
Page 1 to Page 6, Low Byte Address = 0x08, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Buffer for y-axis acceleration data
	See Table 32 for scale sensitivity
	Format = twos complement (time), binary (FFT)

Table 62. FFT Mode, 5 g Range, Data Format Examples

Acceleration (mg)	LSB	Hex	Binary
4,999.9237	65,535	0xFFFF	1111 1111 1111 1111
$100 \times 5 \div 65,536$	100	0x0064	0000 0000 0110 0100
$2 \times 5 \div 65,536$	2	0x0002	0000 0000 0000 0010
$1 \times 5 \div 65,536$	1	0x0001	0000 0000 0000 0001
0	0	0x0000	0000 0000 0000 0000

Table 63. Manual Time Mode, 5 g Range, Data Format Examples

Acceleration (mg)	LSB	Hex	Binary
4999.847	32,767	0x7FFF	1111 1111 1111 1111
~1000	6,554	0x199A	0001 0001 1001 1010
$2 \times 5 \div 32,768$	2	0x0002	0000 0000 0000 0010
$1 \times 5 \div 32,768$	1	0x0001	0000 0000 0000 0001
0	0	0x0000	0000 0000 0000 0000
$-1 \times +5 \div +32,768$	-1	0xFFFF	1111 1111 1111 1111
$-2 \times +5 \div +32,768$	-2	0xFFFE	1111 1111 1111 1110
~-1000	-6554	0xE666	1110 0110 0110 0110
-5000	$-32,768$	0x8000	1000 0000 0000 0000

REAL-TIME DATA COLLECTION

When using real-time mode, select the output channel by reading the associated x_BUF register. For example, set DIN = 0x0880 to select the y-axis sensor for sampling. After selecting the channel, use the data ready signal to trigger subsequent data reading of the Y_BUF register. In this mode, use the time domain data formatting for a range setting of 20 g, as shown in Table 32.

POWER SUPPLY/TEMPERATURE

Both the ADIS16000 and the ADIS16229 offer power supply and temperature measurements. The ADIS16229 performs these measurements at the end of each spectral record, while the ADIS16000 does so continuously. The power supply measurements (SUPPLY_OUT_x, see Table 64 and Table 65) come from averaging a data record of 256 samples (50 kSPS). The temperature measurements (TEMP_OUT_x, see Table 67 and Table 68) come from averaging a data record of 64 samples, which cover a total time of 1.7 ms. When using real-time mode, these registers update only when this mode starts.

Table 64. SUPPLY_OUT_G,
Page 0, Low Byte Address = 0x0E, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Power supply, binary, 3.3 V = 0x1D46, 0.44 mV/LSB

Table 65. SUPPLY_OUT_S,
Page 1 to Page 6, Low Byte Address = 0x0C, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Power supply, binary, 3.3 V = 0x1D46, 0.44 mV/LSB

Table 66. Power Supply Data Format Examples

Supply Level (V)	LSB	Hex	Binary
3.6	8182	0x1FF6	0001 1111 1111 0110
3.3 + 0.00044	7501	0x1D4D	0001 1101 0100 1101
3.3	7500	0x1D4C	0001 1101 0100 1100
3.3 − 0.00044	7499	0x1D4B	0001 1101 0100 1011
3.15	7159	0x1BF7	0001 1011 1111 0111

Table 67. TEMP_OUT_G,
Page 0, Low Byte Address = 0x0C, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Temperature data, offset binary, 4584 LSB = 0°C, −0.0815°C/LSB

Table 68. TEMP_OUT_S,
Page 1 to Page 6, Low Byte Address = 0x0A, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Temperature data, offset binary, 4584 LSB = 0°C, −0.0815°C/LSB

Table 69. Internal Temperature Data Format Examples

Temperature (°C)	LSB	Hex	Binary
125	3050	0x0BEA	0000 1011 1110 1010
0 + 0.0815	4583	0x11E7	0001 0001 1110 0111
0	4584	0x11E8	0001 0001 1110 1000
0 − 0.0815	4585	0x11E9	0001 0001 1110 1001
−40	5075	0x13D3	0001 0011 1101 0011

FFT EVENT HEADER

Each FFT record has an FFT header containing information that fills all of the registers listed in Table 70. The information in these registers contains recording time, record configuration settings, status/error flags, and several alarm outputs. The registers listed in Table 70 update with every record event and also update with record-specific information when using GLOB_CMD_S[13] (see Table 75) to retrieve a data set from the FFT record in flash memory.

Table 70. FFT Header Register Information

Register	Address	Description
DIAG_STAT_S	0x34	Alarm status
ALM_X_STAT	0x38	X-axis alarm status
ALM_Y_STAT	0x3A	Y-axis alarm status
ALM_X_PEAK	0x3C	X-axis alarm peak
ALM_Y_PEAK	0x3E	Y-axis alarm peak
TIME_STMP_L	0x40	Time stamp, lower word
TIME_STMP_H	0x42	Time stamp, upper word
ALM_X_FREQ	0x44	X-axis alarm frequency of peak alarm
ALM_Y_FREQ	0x46	Y-axis alarm frequency of peak alarm
REC_INFO1	0x4C	FFT record header information
REC_INFO2	0x4E	FFT record header information

The REC_INFO1 register (see Table 71) and the REC_INFO2 register (see Table 72) capture the settings associated with the current FFT record.

Table 71. REC_INFO1,
Page 1 to Page 6, Low Byte Address = 0x4C, Read Only

Bits	Description (Default = 0x0008)
[15:14]	Sample rate option; 00 = SR0, 01 = SR1, 10 = SR2, 11 = SR3
[13:12]	Window setting; 00 = rectangular, 01 = Hanning, 10 = flat top, 11 = not applicable
[11:10]	Signal range; 00 = 1 g, 01 = 5 g, 10 = 10 g, 11 = 20 g
[9:8]	Not used (don't care)
[7:0]	FFT averages; range = 0 to 255

Table 72. REC_INFO2,
Page 1 to Page 6, Low Byte Address = 0x4E, Read Only

Bits	Description (Default = 0x0000)
[15:4]	Not used (don't care)
[3:0]	AVG_CNT setting

The TIME_STMP_x registers (see Table 73 and Table 74) provide a relative time stamp that identifies the time for the current FFT record.

Table 73. TIME_STMP_L,
Page 1 to Page 6, Low Byte Address = 0x40, Read Only

Bits	Description (Default = 0x0000)
[15:0]	Record time stamp, low integer, binary, seconds

Table 74. TIME_STMP_H,
Page 1 to Page 6, Low Byte Address = 0x42, Read Only

Bits	Description (Default = 0x0000)
[15:0]	Record time stamp, high integer, binary, seconds

SYSTEM TOOLS
GLOBAL COMMANDS

The GLOB_CMD_S register (see Table 75) provides an array of single write commands for convenience. Setting the assigned bit to 1 activates each function. When the function completes, the bit restores itself to 0. For example, clear the capture buffers by setting GLOB_CMD_S[8] = 1 (DIN = 0xB701). All of the commands in the GLOB_CMD_S register require that the power supply be within normal limits for the execution times listed in Table 75.

Table 75. GLOB_CMD_S,
Page 1 to Page 6, Low Byte Address = 0x36, Write Only

Bits	Description (Default = Not Applicable)
15	Clear autonull correction
14	Retrieve spectral alarm band information from the ALM_PNTR setting
13	Retrieve record data from flash memory
12	Save spectral alarm band registers to SRAM
11	Record start/stop
10	Set BUF_PNTR = 0x0000
9	Clear spectral alarm band registers from flash memory
8	Clear records
7	Software reset
6	Save registers to flash memory
5	Flash test, compare sum of flash memory with factory value
4	Clear DIAG_STAT_S register
3	Restore factory register settings and clear the capture buffers
2	Self-test, result in DIAG_STAT_S[5]
1	Power-down
0	Autonull

DEVICE IDENTIFICATION

Table 76. LOT_ID1_G,
Page 0, Low Byte Address = 0x1A, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Lot identification code

Table 77. LOT_ID1_S,
Page 1 to Page 6, Low Byte Address = 0x68, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Lot identification code

Table 78. LOT_ID2_G,
Page 0, Low Byte Address = 0x1C, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Lot identification code

Table 79. LOT_ID2_S,
Page 1 to Page 6, Low Byte Address = 0x6A, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Lot identification code

Table 80. PROD_ID_G,
Page 0, Low Byte Address = 0x16, Read Only

Bits	Description (Default = 0x3E80)
[15:0]	0x3E80 = 16,000

Table 81. PROD_ID_S,
Page 1 to Page 6, Low Byte Address = 0x48, Read Only

Bits	Description (Default = 0x3F65)
[15:0]	0x3F65 = 16,229

Table 82. SERIAL_NUM_G,
Page 0, Low Byte Address = 0x24, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Serial number, lot specific

Table 83 shows a blank register that is available for writing user-specific identification.

Table 83. USER_SCR,
Page 1 to Page 6, Low Byte Address = 0x64, Read Only

Bits	Description (Default = 0x0000)
[15:0]	User scratch register

Table 84. GPO_CTRL,
Page 0, Low Byte Address = 0x2A, Read/Write

Bits	Description (Default = 0x0008)
[15:6]	Not used
[5:4]	DO2 function selection
	00 = general-purpose
	01 = alarm indicator
	10 = busy indicator/data ready (real-time mode)
	11 = not used
[3:2]	DO1 function selection
	00 = general-purpose
	01 = alarm indicator
	10 = busy indicator/data ready (real-time mode)
	11 = not used
1	DO2 polarity
	1 = active high
	0 = active low
0	DO1 polarity
	1 = active high
	0 = active low

SYSTEM FLAGS

Critical system flags are in the DIAG_STAT_x registers (see Table 85 and Table 86) for each ADIS16229. These flags indicate various indicators for monitoring the network. Multiple flags in these registers can be high at one time, and the flags persist (that is, go high again, after clearing) when the error conditions continue to exist. The flags in DIAG_STAT_S[6:0] remain in a latch condition until the problem clears or the flags are cleared using GLOB_CMD_S[4]. All of the alarm flags in the upper byte (DIAG_STAT_S[15:8] latch if ALM_CTRL[7] = 1 (see Table 42).

Table 85. DIAG_STAT_G,
Page 0, Low Byte Address = 0x2C, Read Only

Bits	Description (Default = 0x0000)
15	Not used
14	System alarm; 1 = alarm condition
13	Sensor Node 6 new data; 1 = new data received
12	Sensor Node 5 new data; 1 = new data received
11	Sensor Node 4 new data; 1 = new data received
10	Sensor Node 3 new data; 1 = new data received
9	Sensor Node 2 new data; 1 = new data received
8	Sensor Node 1 new data; 1 = new data received
7	Command completion; 1 = completed
6	Flash memory failure, from GLOB_CMD_S[5] test (see Table 75)
[5:4]	Not used
3	SPI communication; 1 = SCLKs ≠ multiple of 16
2	Flash update failure
1	Power supply > 3.625 V
0	Power supply < 2.0 V

Table 86. DIAG_STAT_S,
Page 1 to Page 6, Low Byte Address = 0x34, Read Only

Bits	Description (Default = 0x0000)
15	Not used
14	System alarm; 1 = error condition exists, 0 = no error
13	Not used
12	Alarm 2, Y-axis; 1 = alarm condition, 0 = no alarm
11	Alarm 2, X-axis; 1 = alarm condition, 0 = no alarm
10	Not used
9	Alarm 1, Y-axis; 1 = alarm condition, 0 = no alarm
8	Alarm 1, X-axis; 1 = alarm condition, 0 = no alarm
7	Not used
6	Flash memory failure, from GLOB_CMD_S[5] test (see Table 75)
5	Self-test (1 = fail, 0 = pass)
4	Record process interrupted
3	Not used
2	Flash update failure
1	Power supply > 3.625 V
0	Power supply < 2.0 V

SELF-TEST

Set GLOB_CMD_S[2] = 1 (DIN = 0xB602) (see Table 75) to run an automatic self-test routine, which reports a pass/fail result to DIAG_STAT_S[5] (see Table 85).

FLASH MEMORY MANAGEMENT

Set GLOB_CMD_S[5] = 1 (DIN = 0xB620) to run an internal checksum test on the flash memory, which reports a pass/fail result to DIAG_STAT_S[6]. The FLASH_CNT_S register (see Table 87) provides a running count of flash memory write cycles in each ADIS16229. This is a tool for managing the endurance of the flash memory. The FLASH_CNT_G (see Table 87) register provides this function for the ADIS16000 as well. Figure 25 quantifies the relationship between data retention and junction temperature.

Table 87. FLASH_CNT_G,
Page 0, Low Byte Address = 0x04, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Binary counter for writing to flash memory

Table 88. FLASH_CNT_S,
Page 1 to Page 6, Low Byte Address = 0x04, Read Only

Bits	Description (Default = Not Applicable)
[15:0]	Binary counter for writing to flash memory
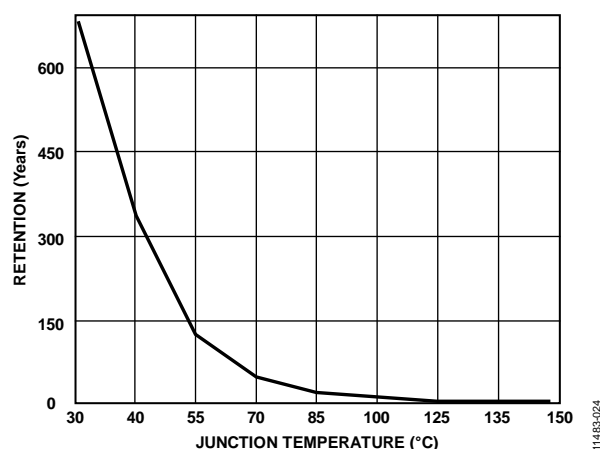
Figure 25. Flash Memory Data Retention vs. Junction Temperature

OUTLINE DIMENSIONS

Figure 26. 14-Pin Connector Multichip Chip Module Laminate [MCML]
(ML-14-4)
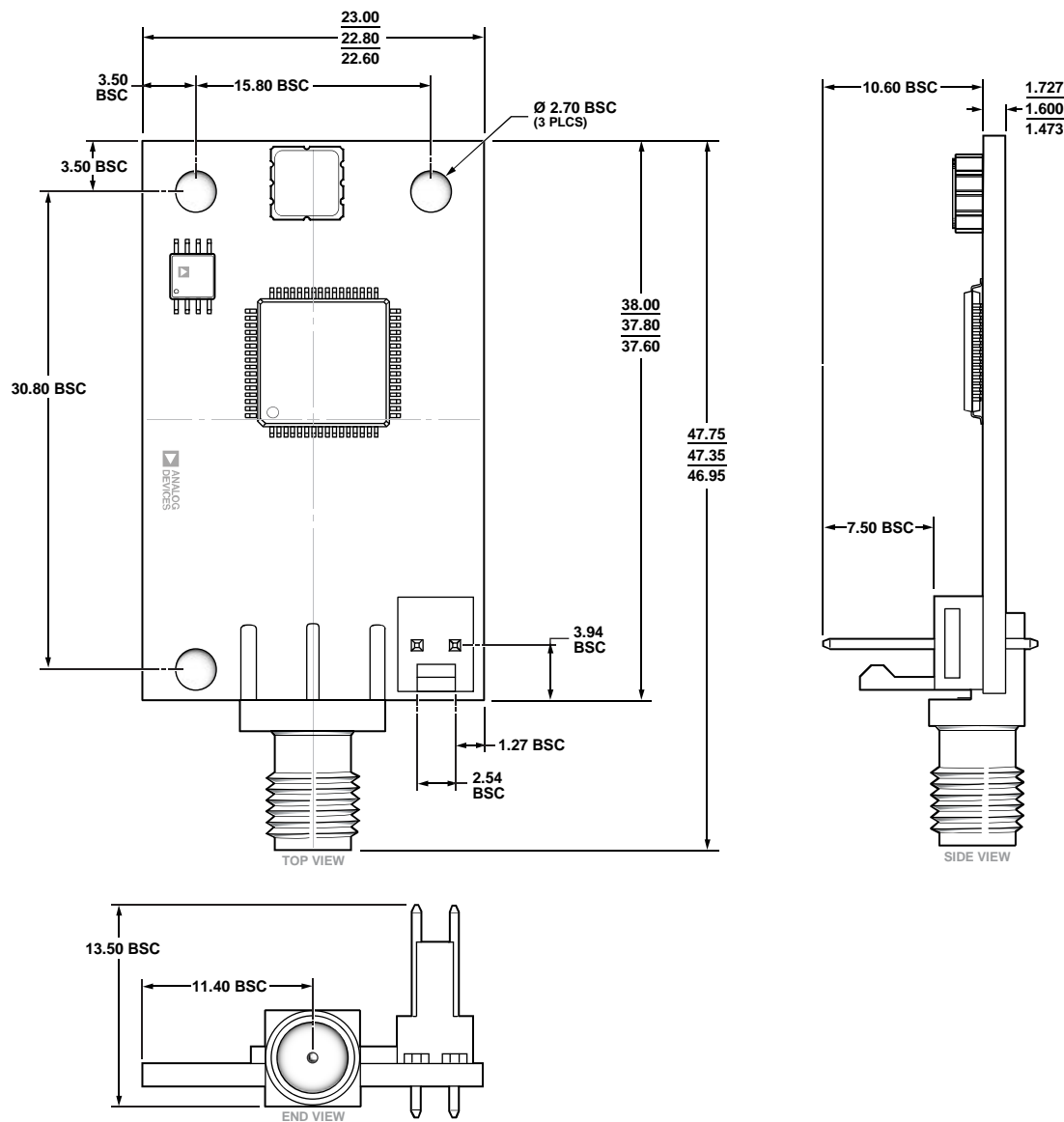*Dimensions shown in millimeters*

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Figure 27. 2-Pin Multichip Chip Module Laminate [MCML]
(ML-2-1)
Dimensions shown in millimeters

ORDERING GUIDE

Model[1]	Temperature Range	Package Description	Package Option
ADIS16000AMLZ	−40°C to +85°C	14-Pin Connector Multichip Chip Module Laminate [MCML]	ML-14-4
ADIS16229AMLZ	−40°C to +85°C	2-Pin Multichip Chip Module Laminate [MCML]	ML-2-1

[1] Z = RoHS Compliant Part.

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